

# 60V Synchronous 4-Switch Buck-Boost LED Controller with Spread Spectrum

## FEATURES

- **4-Switch Single Inductor Architecture Allows  $V_{IN}$  Above, Below or Equal to  $V_{OUT}$**
- **Synchronous Switching: Up to 98% Efficiency**
- **Proprietary Peak-Buck Peak-Boost Current Mode**
- **Wide  $V_{IN}$  Range: 4V to 60V**
- **Wide  $V_{OUT}$  Range: 0V to 60V (51V LED)**
- **±3% LED Current Accuracy**
- **2000:1 External and 128:1 Internal PWM Dimming**
- **High Side PMOS PWM Switch Driver**
- **Integrated Bootstrap Diodes**
- **No Top MOSFET Refresh Noise in Buck or Boost**
- **Adjustable and Synchronizable: 150kHz to 650kHz**
- **Flicker-Free Spread Spectrum for Low EMI**
- **Open and Short LED Protection with Fault Reporting**
- **Available in 28-Lead TSSOP with Exposed Pad and 28-Lead QFN (4mm × 5mm)**
- **AEC-Q100 Qualified for Automotive Applications**

## DESCRIPTION

The **LT®8391** is a synchronous 4-switch buck-boost LED controller that regulates LED current from input voltage above, below or equal to the output voltage. The proprietary peak-buck peak-boost current mode control scheme allows adjustable and synchronizable 150kHz to 650kHz fixed frequency operation, or internal ±15% triangle spread spectrum operation for low EMI. With 4V to 60V input, 0V to 60V output, and seamless low noise transitions between operation regions, the LT8391 is ideal for LED driver and battery charger applications in automotive, industrial and battery-powered systems.

The LT8391 provides both internal (up to 128:1) and external (up to 2000:1) LED current PWM dimming with a high side PMOS switch. Two CTRL pins provide flexible 20:1 analog dimming with ±3% LED current accuracy at 100mV full scale. Fault protection is provided to detect an open or short LED condition, during which the LT8391 retries, latches off, or keeps running.

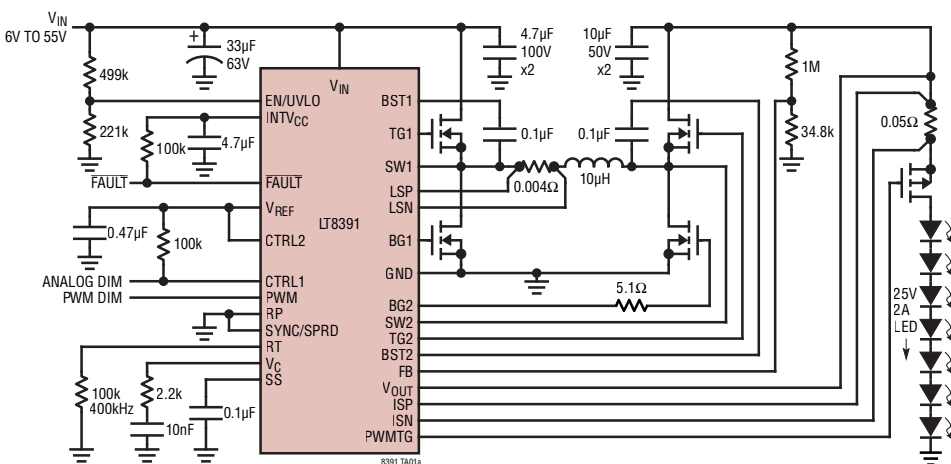
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## APPLICATIONS

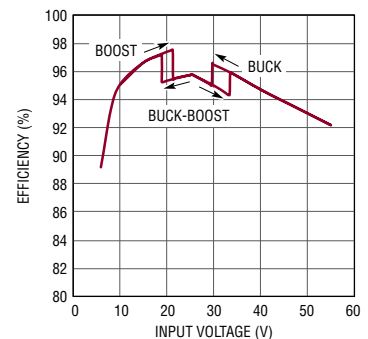
- Automotive Head Lamps/Running Lamps
- High Power LED Lighting

## TYPICAL APPLICATION

**98% Efficient 50W (25V, 2A) Buck-Boost LED Driver**



**Efficiency vs  $V_{IN}$**



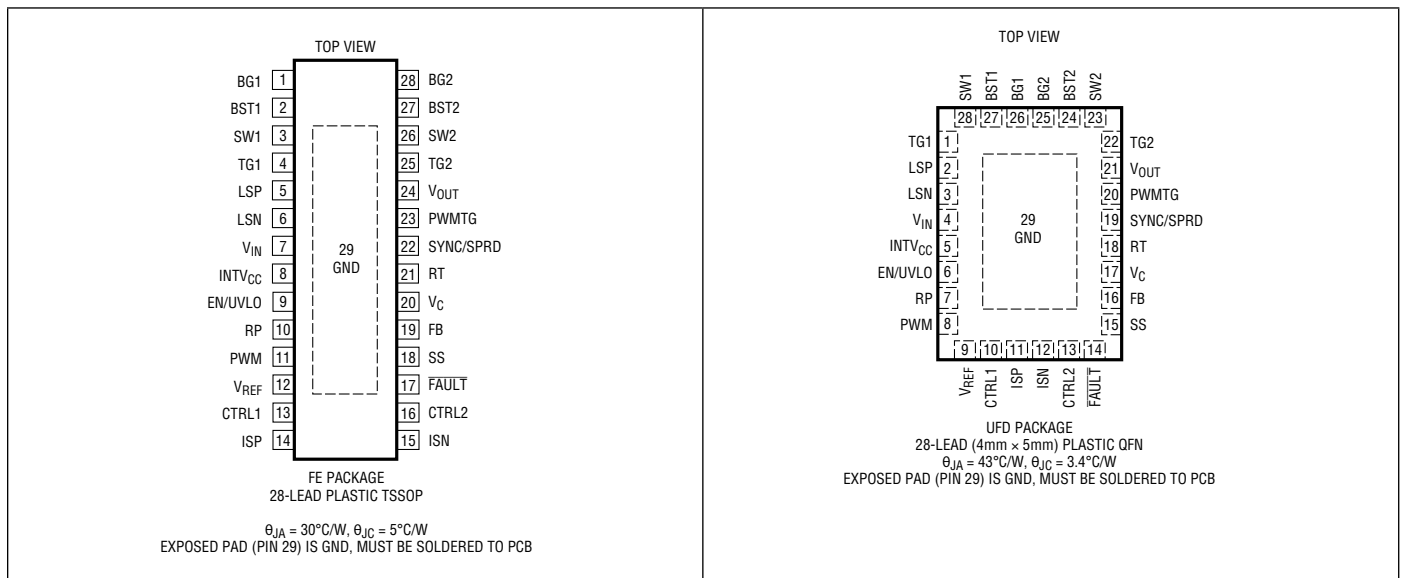
# LT8391

## ABSOLUTE MAXIMUM RATINGS (Note 1)

$V_{IN}$ , EN/UVLO, $V_{OUT}$ , ISP, ISN .....	60V
(ISP-ISN) .....	-1V to 1V
BST1, BST2.....	66V
SW1, SW2, LSP, LSN .....	-6V to 60V
INTV <sub>CC</sub> , (BST1-SW1), (BST2-SW2).....	6V
(BST1-LSP), (BST1-LSN) .....	6V
FB, PWM, SYNC/SPRD, CTRL1, CTRL2, FAULT.....	6V

Operating Junction Temperature Range (Notes 2, 3)	
LT8391E.....	-40°C to 125°C
LT8391I.....	-40°C to 125°C
LT8391J.....	-40°C to 150°C
LT8391H .....	-40°C to 150°C
Storage Temperature Range .....	-65°C to 150°C

## PIN CONFIGURATION



## ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LT8391EFE#PBF	LT8391EFE#TRPBF	LT8391FE	28-Lead Plastic TSSOP	-40°C to 125°C
LT8391IFE#PBF	LT8391IFE#TRPBF	LT8391FE	28-Lead Plastic TSSOP	-40°C to 125°C
LT8391HFE#PBF	LT8391HFE#TRPBF	LT8391FE	28-Lead Plastic TSSOP	-40°C to 150°C
LT8391JFE#PBF	LT8391JFE#TRPBF	LT8391FE	28-Lead Plastic TSSOP	-40°C to 150°C
LT8391EUFD#PBF	LT8391EUFD#TRPBF	8391	28-Lead (4mm × 5mm) Plastic QFN	-40°C to 125°C
LT8391IUFD#PBF	LT8391IUFD#TRPBF	8391	28-Lead (4mm × 5mm) Plastic QFN	-40°C to 125°C
LT8391JUFD#PBF	LT8391JUFD#TRPBF	8391	28-Lead (4mm × 5mm) Plastic QFN	-40°C to 150°C
LT8391HUFD#PBF	LT8391HUFD#TRPBF	8391	28-Lead (4mm × 5mm) Plastic QFN	-40°C to 150°C
<b>AUTOMOTIVE PRODUCTS**</b>				
LT8391JFE#WPBF	LT8391JFE#WTRPBF	LT8391FE	28-Lead Plastic TSSOP	-40°C to 150°C
LT8391HFE#WPBF	LT8391HFE#WTRPBF	LT8391FE	28-Lead Plastic TSSOP	-40°C to 150°C

Contact the factory for parts specified with wider operating temperature ranges. \*The temperature grade is identified by a label on the shipping container.

[Tape and reel specifications](#). Some packages are available in 500 unit reels through designated sales channels with #TRMPBF suffix.

\*\*Versions of this part are available with controlled manufacturing to support the quality and reliability requirements of automotive applications. These models are designated with a #W suffix. Only the automotive grade products shown are available for use in automotive applications. Contact your local Analog Devices account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for these models.

## ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ . (Note 2).  $V_{IN} = 12\text{V}$ ,  $V_{EN/UVLO} = 1.5\text{V}$  unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
	$V_{IN}$ Operating Voltage Range		●	4	60	V
	$V_{IN}$ Quiescent Current	$V_{EN/UVLO} = 0.3\text{V}$ $V_{EN/UVLO} = 1.1\text{V}$ Not Switching		1 270 2.1	2 2.8	$\mu\text{A}$ $\mu\text{A}$ mA
	$V_{OUT}$ Voltage Range		●	0	60	V
	$V_{OUT}$ Quiescent Current	$V_{EN/UVLO} = 0.3\text{V}$ , $V_{OUT} = 12\text{V}$ $V_{EN/UVLO} = 1.1\text{V}$ , $V_{OUT} = 12\text{V}$ Not Switching, $V_{OUT} = 12\text{V}$		0.1 0.1 20	0.5 0.5 60	$\mu\text{A}$ $\mu\text{A}$ $\mu\text{A}$

### Linear Regulators

	INTV <sub>CC</sub> Regulation Voltage	$I_{INTVCC} = 20\text{mA}$		4.85	5.0	5.15	V
	INTV <sub>CC</sub> Load Regulation	$I_{INTVCC} = 0\text{mA}$ to 80mA			1	4	%
	INTV <sub>CC</sub> Line Regulation	$I_{INTVCC} = 20\text{mA}$ , $V_{IN} = 6\text{V}$ to 60V			1	4	%
	INTV <sub>CC</sub> Current Limit	$V_{INTVCC} = 4.5\text{V}$		80	110	160	mA
	INTV <sub>CC</sub> Dropout Voltage ( $V_{IN} - \text{INTV}_{CC}$ )	$I_{INTVCC} = 20\text{mA}$ , $V_{IN} = 4\text{V}$			160		mV
	INTV <sub>CC</sub> Undervoltage Lockout Threshold	Falling		3.44	3.54	3.64	V
	INTV <sub>CC</sub> Undervoltage Lockout Hysteresis				0.24		V
	$V_{REF}$ Regulation Voltage	$I_{VREF} = 100\mu\text{A}$	●	1.97	2.00	2.03	V
	$V_{REF}$ Load Regulation	$I_{VREF} = 0\text{mA}$ to 1mA			0.4	1	%
	$V_{REF}$ Line Regulation	$I_{VREF} = 100\mu\text{A}$ , $V_{IN} = 4\text{V}$ to 60V			0.1	0.2	%
	$V_{REF}$ Current Limit	$V_{REF} = 1.8\text{V}$		2	2.5	3.2	mA
	$V_{REF}$ Undervoltage Lockout Threshold	Falling		1.78	1.84	1.90	V
	$V_{REF}$ Undervoltage Lockout Hysteresis				50		mV

### Control Inputs/Outputs

	EN/UVLO Shutdown Threshold		●	0.3	0.6	1.0	V
	EN/UVLO Enable Threshold	Falling	●	1.190	1.214	1.238	V
	EN/UVLO Enable Hysteresis				13		mV
	EN/UVLO Hysteresis Current	$V_{EN/UVLO} = 0.3\text{V}$ $V_{EN/UVLO} = 1.1\text{V}$ $V_{EN/UVLO} = 1.3\text{V}$		-0.1 2.2 -0.1	0 2.5 0	0.1 2.8 0.1	$\mu\text{A}$ $\mu\text{A}$ $\mu\text{A}$
	CTRL1, CTRL2 Input Bias Current	$V_{CTRL1/2} = 0.75\text{V}$ (Note 4), Current out of Pin		0	20	50	nA
	CTRL1, CTRL2 Dim-Off Threshold	Falling	●	190	200	210	mV
	CTRL1, CTRL2 Dim-Off Hysteresis				28		mV

### PWM Dimming

	External PWM Dimming Threshold	Rising, $R_P = 30\text{k}$	●	1.3	1.4	1.5	V
	External PWM Dimming Hysteresis	$R_P = 30\text{k}$			220		mV
	Internal PWM Dimming Duty Cycle	$V_{PWM} = 1\text{V}$ , $R_P \geq 51\text{k}$ $V_{PWM} = 1.5\text{V}$ , $R_P \geq 51\text{k}$ $V_{PWM} = 2\text{V}$ , $R_P \geq 51\text{k}$		47 97	3 53		% % %
	Switching Frequency to Internal PWM Dimming Frequency Ratio	$R_P = 51\text{k}$ $R_P = 82\text{k}$ $R_P = 130\text{k}$ $R_P = 200\text{k}$ $R_P = 300\text{k}$			256 512 1024 2048 4096		

**ELECTRICAL CHARACTERISTICS** The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T<sub>A</sub> = 25°C. (Note 2). V<sub>IN</sub> = 12V, V<sub>EN/UVLO</sub> = 1.5V unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
	RP Pin Current Limit	V <sub>RP</sub> = 0V, Current out of Pin		40		μA
	Minimum V <sub>OUT</sub> for PWM TG to be On	PWM Dimming On		2.4	3	V
	PWM TG On Voltage V <sub>(VOUT-PWMTG)</sub>	V <sub>OUT</sub> = 12V	4.6	5	5.4	V
	PWM TG Off Voltage V <sub>(VOUT-PWMTG)</sub>	V <sub>OUT</sub> = 12V	-0.1	0	0.1	V
	PWM to PWM TG Turn On Propagation Delay	C <sub>PWMTG</sub> = 3.3nF to V <sub>OUT</sub> , 50% to 50%		90		ns
	PWM to PWM TG Turn Off Propagation Delay	C <sub>PWMTG</sub> = 3.3nF to V <sub>OUT</sub> , 50% to 50%		40		ns
	PWM TG Turn On Fall Time	C <sub>PWMTG</sub> = 3.3nF to V <sub>OUT</sub> , 10% to 90%		300		ns
	PWM TG Turn Off Rise Time	C <sub>PWMTG</sub> = 3.3nF to V <sub>OUT</sub> , 90% to 10%		10		ns

**Error Amplifier**

	Full Scale LED Current Regulation V <sub>(ISP-ISN)</sub>	V <sub>CTRL1/2</sub> ≥ 1.35V (Note 4), V <sub>ISP</sub> = 12V V <sub>CTRL1/2</sub> ≥ 1.35V (Note 4), V <sub>ISP</sub> = 0V	● ●	97 97	100 100	103 103	mV mV
	9/10th LED Current Regulation V <sub>(ISP-ISN)</sub>	V <sub>CTRL1/2</sub> = 1.15V (Note 4), V <sub>ISP</sub> = 12V V <sub>CTRL1/2</sub> = 1.15V (Note 4), V <sub>ISP</sub> = 0V	● ●	87 87	90 90	93 93	mV mV
	1/2 LED Current Regulation V <sub>(ISP-ISN)</sub>	V <sub>CTRL1/2</sub> = 0.75V (Note 4), V <sub>ISP</sub> = 12V V <sub>CTRL1/2</sub> = 0.75V (Note 4), V <sub>ISP</sub> = 0V	● ●	47.5 47.5	50 50	52.5 52.5	mV mV
	1/20th LED Current Regulation V <sub>(ISP-ISN)</sub>	V <sub>CTRL1/2</sub> = 0.30V (Note 4), V <sub>ISP</sub> = 12V V <sub>CTRL1/2</sub> = 0.30V (Note 4), V <sub>ISP</sub> = 0V	● ●	3 3	5 5	7 7	mV mV
	Zero Scale LED Current Regulation V <sub>(ISP-ISN)</sub>	V <sub>CTRL1/2</sub> = 0.25V (Note 4), V <sub>ISP</sub> = 12V V <sub>CTRL1/2</sub> = 0.25V (Note 4), V <sub>ISP</sub> = 0V	● ●	-2 -2	0 0	2 2	mV mV
	ISP/ISN Input Common Mode Range		●	0		60	V
	ISP/ISN Low Side to High Side Switchover Voltage	V <sub>ISP</sub> = V <sub>ISN</sub>			1.8		V
	ISP/ISN High Side to Low Side Switchover Voltage	V <sub>ISP</sub> = V <sub>ISN</sub>			1.7		V
	ISP Input Bias Current	V <sub>PWM</sub> = 5V, V <sub>ISP</sub> = V <sub>ISN</sub> = 12V V <sub>PWM</sub> = 5V, V <sub>ISP</sub> = V <sub>ISN</sub> = 0V V <sub>EN/UVLO</sub> = 0V, V <sub>ISP</sub> = V <sub>ISN</sub> = 12V or 0V			23 -10 0		μA μA μA
	ISN Input Bias Current	V <sub>PWM</sub> = 5V, V <sub>ISP</sub> = V <sub>ISN</sub> = 12V V <sub>PWM</sub> = 5V, V <sub>ISP</sub> = V <sub>ISN</sub> = 0V V <sub>EN/UVLO</sub> = 0V, V <sub>ISP</sub> = V <sub>ISN</sub> = 12V or 0V			23 -10 0		μA μA μA
	LED Current Regulation Amplifier g <sub>m</sub>				2000		μS
	FB Regulation Voltage	V <sub>C</sub> = 1.2V	●	0.98	1.00	1.02	V
	FB Line Regulation	V <sub>IN</sub> = 4V to 60V			0.2	0.5	%
	FB Load Regulation				0.2	0.8	%
	FB Voltage Regulation Amplifier g <sub>m</sub>				660		μS
	FB Input Bias Current	FB in Regulation, Current Out of Pin			10	40	nA
	V <sub>C</sub> Output Impedance				10		MΩ
	V <sub>C</sub> Standby Leakage Current	V <sub>C</sub> = 1.2V, PWM Dimming Off		-10	0	10	nA

**Current Comparator**

	Maximum Current Sense Threshold V <sub>(LSP-LSN)</sub>	Buck, V <sub>FB</sub> = 0.8V Boost, V <sub>FB</sub> = 0.8V	● ●	35 40	50 50	65 60	mV mV
	Reverse Current Sense Threshold V <sub>(LSP-LSN)</sub>	Buck, V <sub>FB</sub> = 0.8V Boost, V <sub>FB</sub> = 0.8V			-4 -4		mV mV
	LSP Pin Bias Current	V <sub>LSP</sub> = V <sub>LSN</sub> = 12V			60		μA
	LSN Pin Bias Current	V <sub>LSP</sub> = V <sub>LSN</sub> = 12V			60		μA

## ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ . (Note 2).  $V_{IN} = 12\text{V}$ ,  $V_{EN/UVLO} = 1.5\text{V}$  unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
<b>Fault</b>							
	FB Overvoltage Threshold ( $V_{FB}$ )	Rising	●	1.03	1.05	1.07	V
	FB Overvoltage Hysteresis		●	15	25	35	mV
	FB Open LED Threshold ( $V_{FB}$ )	Rising, $V_{(ISP-ISN)} = 0\text{V}$	●	0.93	0.95	0.97	V
	FB Open LED Hysteresis	$V_{(ISP-ISN)} = 0\text{V}$	●	35	50	65	mV
	FB Short LED Threshold ( $V_{FB}$ )	Falling	●	0.24	0.25	0.26	V
	FB Short LED Hysteresis	Hysteresis	●	35	50	65	mV
	ISP/ISN Over Current Threshold $V_{(ISP-ISN)}$	$V_{ISP} = 12\text{V}$			750		mV
	ISP/ISN Open LED Threshold $V_{(ISP-ISN)}$	Falling, $V_{FB} = 1.0\text{V}$	●	8	10	12	mV
	ISP/ISN Open LED Hysteresis	$V_{FB} = 1.0\text{V}$	●	3	5	7	mV
	FAULT Pull-Down Resistance				100	200	$\Omega$
	SS Hard Pull-Down Resistance	$V_{EN/UVLO} = 1.1\text{V}$			100	200	$\Omega$
	SS Pull-Up Current	$V_{FB} = 0.8\text{V}$ , $V_{SS} = 0\text{V}$		10.5	12.5	14.5	$\mu\text{A}$
	SS Pull-Down Current	$V_{FB} = 1.0\text{V}$ , $V_{SS} = 2\text{V}$		1.05	1.25	1.45	$\mu\text{A}$
	SS Fault Latch-Off Threshold	Falling			1.7		V
	SS Fault Latch-Off Hysteresis				50		mV
	SS Fault Reset Threshold				0.2		V
<b>Oscillator</b>							
	RT Pin Voltage	$R_T = 100\text{k}\Omega$			1.00		V
	Switching Frequency	$V_{\text{SYNC/SPRD}} = 0\text{V}$ , $R_T = 226\text{k}$ $V_{\text{SYNC/SPRD}} = 0\text{V}$ , $R_T = 100\text{k}$ $V_{\text{SYNC/SPRD}} = 0\text{V}$ , $R_T = 59.0\text{k}$	●	190	200	210	kHz
●			380	400	420	kHz	
●			570	600	630	kHz	
	SYNC Frequency			150		650	kHz
	SYNC/SPRD Input Bias Current	$V_{\text{SYNC/SPRD}} = 5\text{V}$		-0.1	0	0.1	$\mu\text{A}$
	SYNC/SPRD Threshold Voltage			0.4		1.5	V
	Highest Spread Spectrum Above Oscillator Frequency	$V_{\text{SYNC/SPRD}} = 5\text{V}$		12.5	14.5	16.5	%
	Lowest Spread Spectrum Below Oscillator Frequency	$V_{\text{SYNC/SPRD}} = 5\text{V}$		-17.7	-15.7	-13.7	%
<b>Region Transition</b>							
	Buck-Boost to Boost ( $V_{IN}/V_{OUT}$ )			0.73	0.75	0.77	
	Boost to Buck-Boost ( $V_{IN}/V_{OUT}$ )			0.83	0.85	0.87	
	Buck to Buck-Boost ( $V_{IN}/V_{OUT}$ )			1.16	1.18	1.20	
	Buck-Boost to Buck ( $V_{IN}/V_{OUT}$ )			1.31	1.33	1.35	
	Peak-Buck to Peak-Boost ( $V_{IN}/V_{OUT}$ )			0.96	0.98	1.00	
	Peak-Boost to Peak-Buck ( $V_{IN}/V_{OUT}$ )			1.00	1.02	1.04	

**ELECTRICAL CHARACTERISTICS** The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ . (Note 2).  $V_{IN} = 12\text{V}$ ,  $V_{EN/UVLO} = 1.5\text{V}$  unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
<b>NMOS Drivers</b>						
	TG1, TG2 Gate Driver On-Resistance Gate Pull-Up Gate Pull-Down	$V_{(BST-SW)} = 5\text{V}$		2.6 1.4		$\Omega$ $\Omega$
	BG1, BG2 Gate Driver On-Resistance Gate Pull-Up Gate Pull-Down	$V_{INTVCC} = 5\text{V}$		3.2 1.2		$\Omega$ $\Omega$
	TG1, TG2 Rise Time TG1, TG2 Fall Time	$C_L = 3.3\text{nF}$ , 10% to 90% $C_L = 3.3\text{nF}$ , 90% to 10%		25 20		ns ns
	BG1, BG2 Rise Time BG1, BG2 Fall Time	$C_L = 3.3\text{nF}$ , 10% to 90% $C_L = 3.3\text{nF}$ , 90% to 10%		25 20		ns ns
	TG Off to BG On Delay	$C_L = 3.3\text{nF}$		60		ns
	BG Off to TG On Delay	$C_L = 3.3\text{nF}$		60		ns
	TG1 Minimum Duty Cycle in Buck Region	Peak-Buck Current Mode		10		%
	TG1 Maximum Duty Cycle in Buck Region	Peak-Buck Current Mode		95		%
	TG1 Fixed Duty Cycle in Buck-Boost Region	Peak-Boost Current Mode		85		%
	BG2 Fixed Duty Cycle in Buck-Boost Region	Peak-Buck Current Mode		15		%
	BG2 Minimum Duty Cycle in Boost Region	Peak-Boost Current Mode		10		%
	BG2 Maximum Duty Cycle in Boost Region	Peak-Boost Current Mode		95		%

**Note 1:** Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

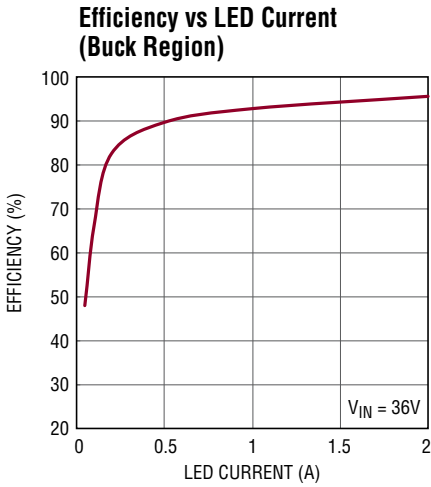
**Note 2:** The LT8391E is guaranteed to meet performance specifications from  $0^\circ\text{C}$  to  $125^\circ\text{C}$  operating junction temperature. Specifications over the  $-40^\circ\text{C}$  to  $125^\circ\text{C}$  operating junction temperature range are assured by design, characterization and correlation with statistical process controls. The LT8391I is guaranteed over the  $-40^\circ\text{C}$  to  $125^\circ\text{C}$  operating junction temperature range. The LT8391H is guaranteed over the  $-40^\circ\text{C}$  to  $150^\circ\text{C}$

operating junction temperature range. The LT8391J specifications over the  $-40^\circ\text{C}$  to  $150^\circ\text{C}$  operating junction temperature range are assured by design, characterization and correlation with statistical process controls. High junction temperatures degrade operating lifetimes. Operating lifetime is derated at junction temperatures greater than  $125^\circ\text{C}$ .

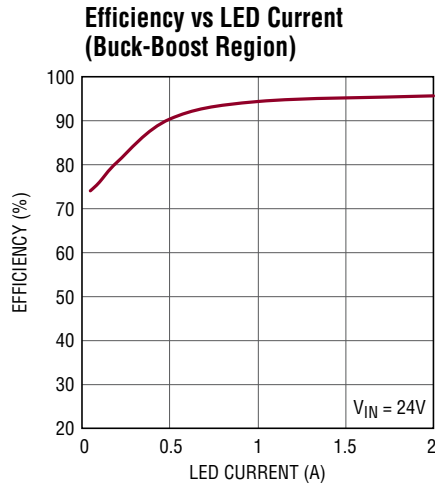
**Note 3:** The LT8391 includes overtemperature protection that is intended to protect the device during momentary overload conditions. Junction temperature will exceed  $150^\circ\text{C}$  when overtemperature protection is active. Continuous operation above the specified absolute maximum operating junction temperature may impair device reliability.

**Note 4:**  $V_{CTRL1/2}$  represents the condition of CTRL1 when CTRL2 is equal to 2V or the condition of CTRL2 when CTRL1 is equal to 2V.

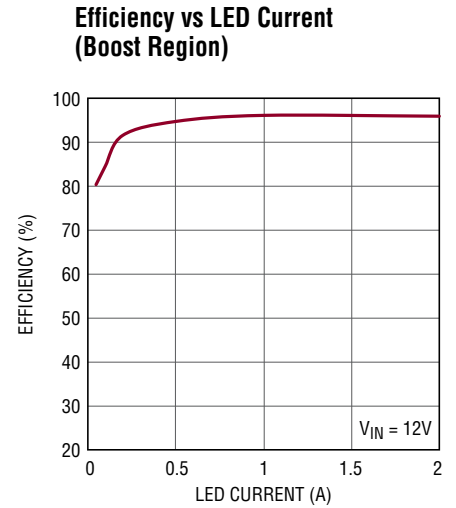
**TYPICAL PERFORMANCE CHARACTERISTICS**  $T_A = 25^\circ\text{C}$ , unless otherwise noted.



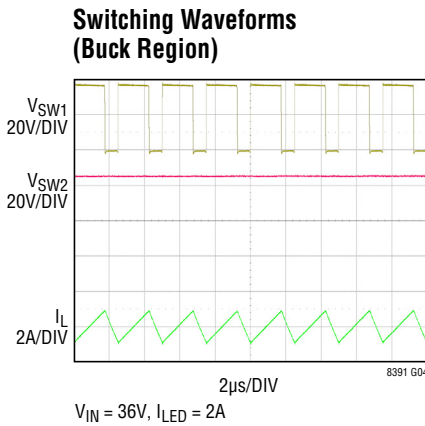
8391 G01



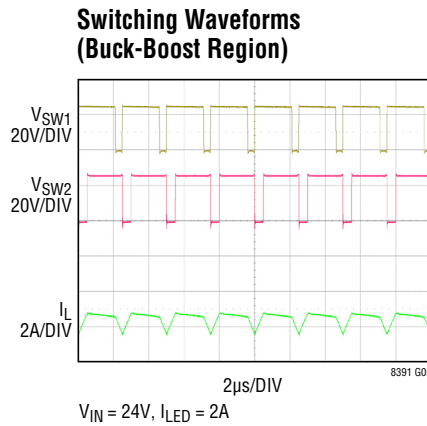
8391 G02



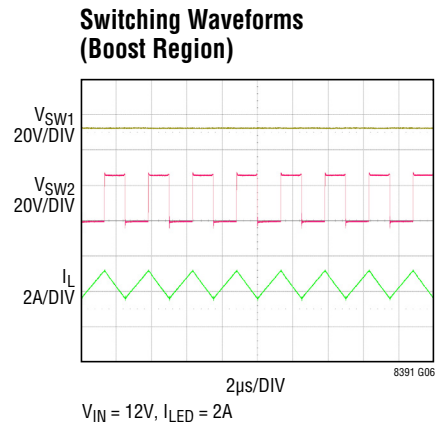
8391 G03



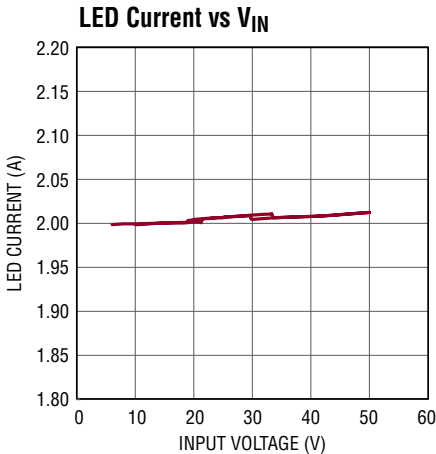
8391 G04



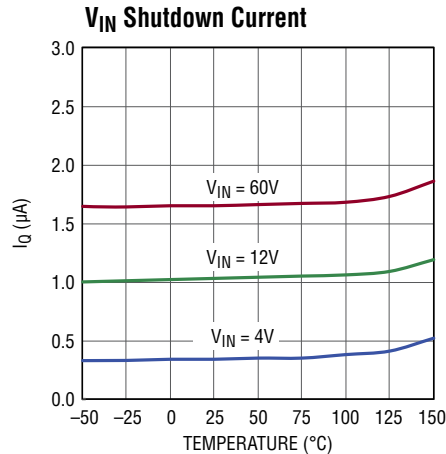
8391 G05



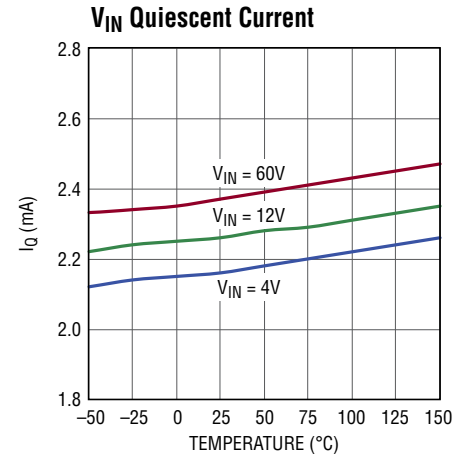
8391 G06



8391 G07



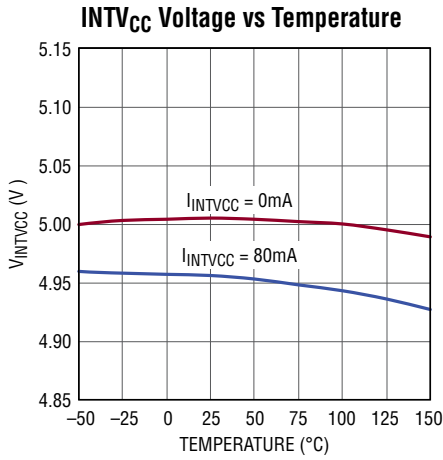
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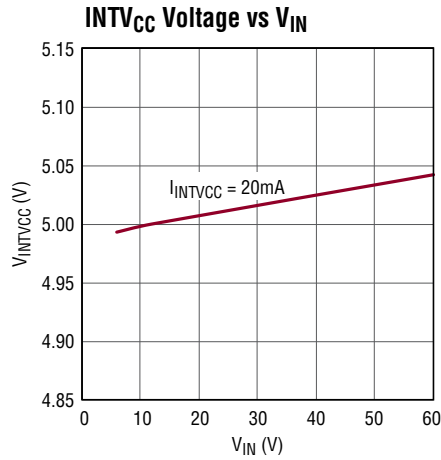
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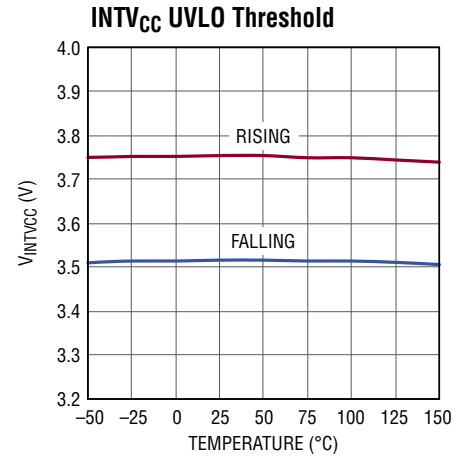
**TYPICAL PERFORMANCE CHARACTERISTICS**  $T_A = 25^\circ\text{C}$ , unless otherwise noted.



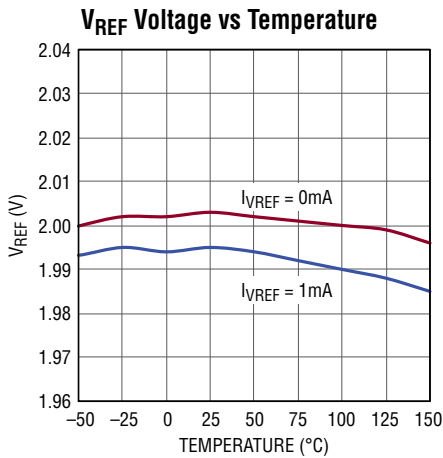
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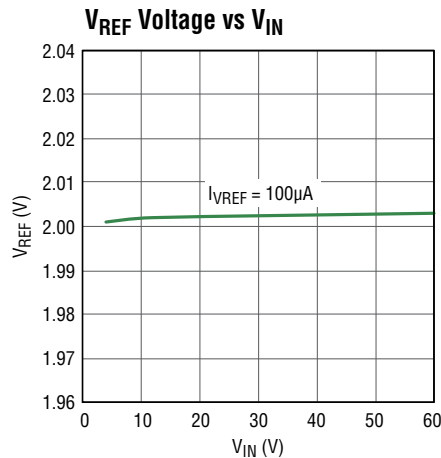
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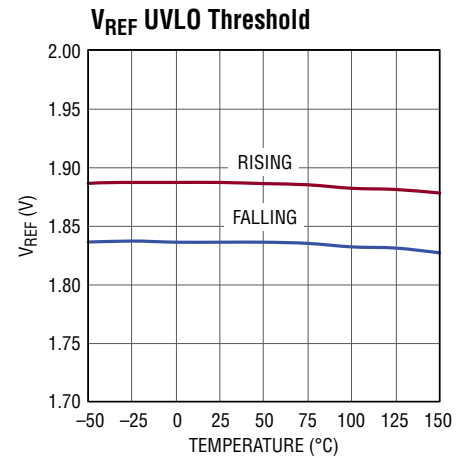
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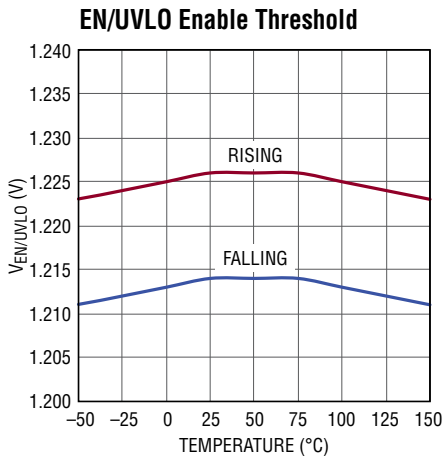
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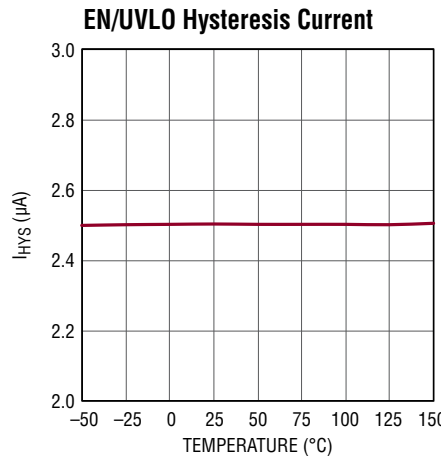
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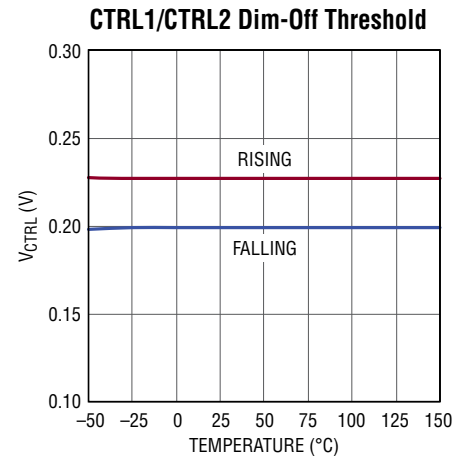
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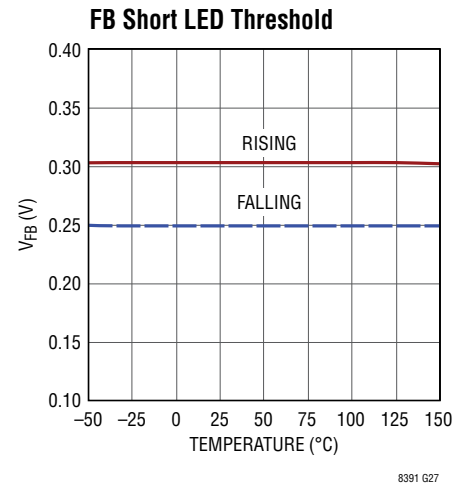
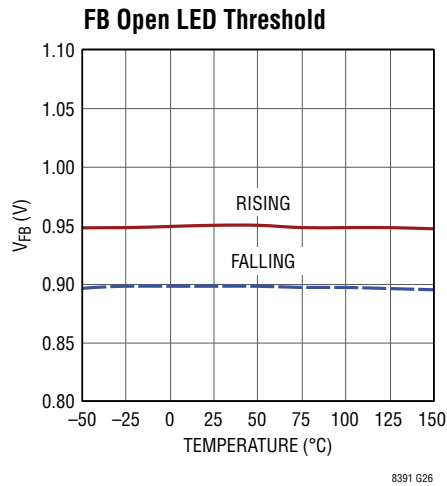
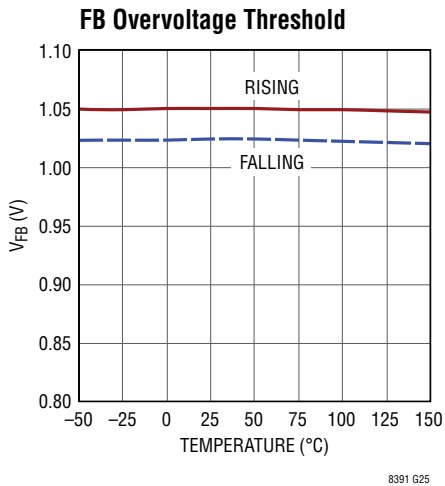
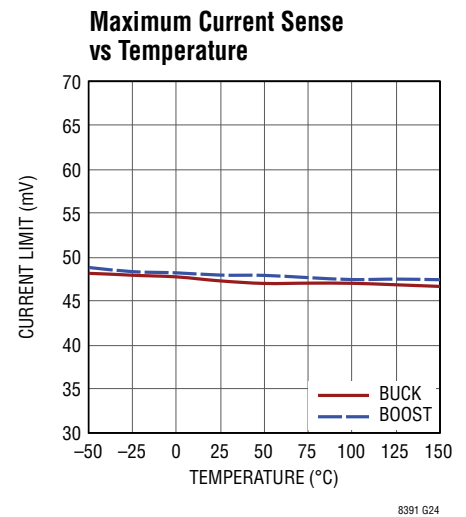
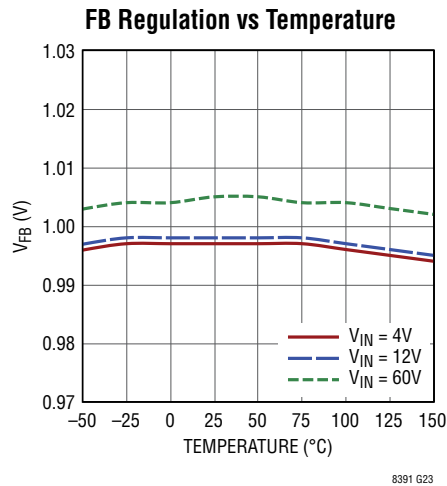
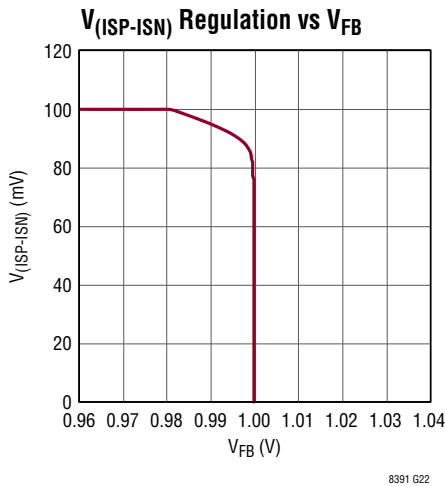
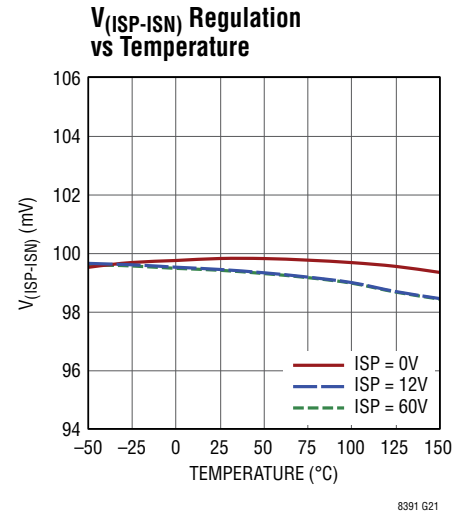
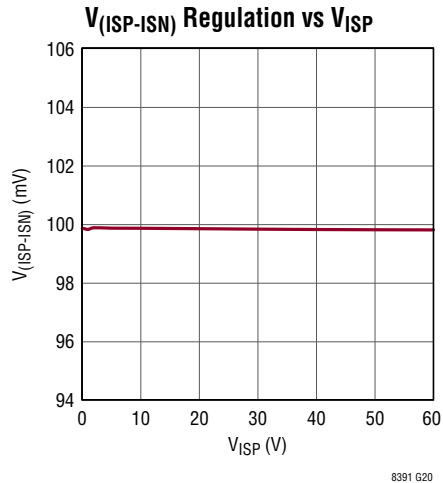
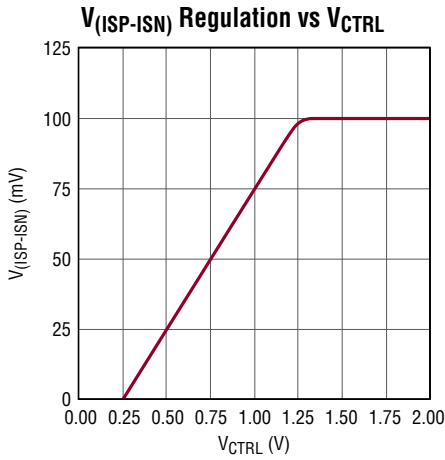


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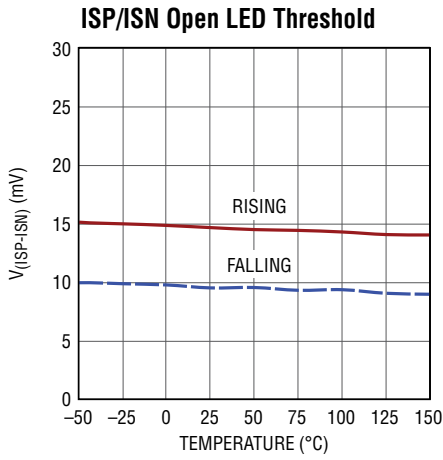


8391 G18

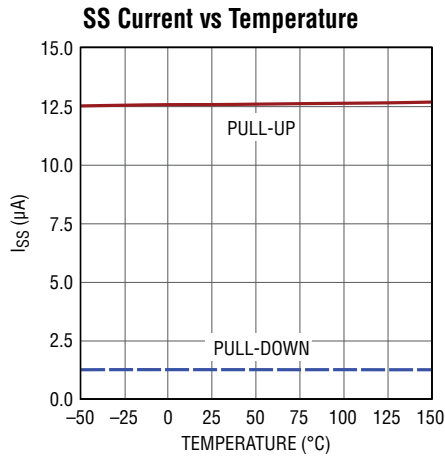
## TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^\circ\text{C}$ , unless otherwise noted.



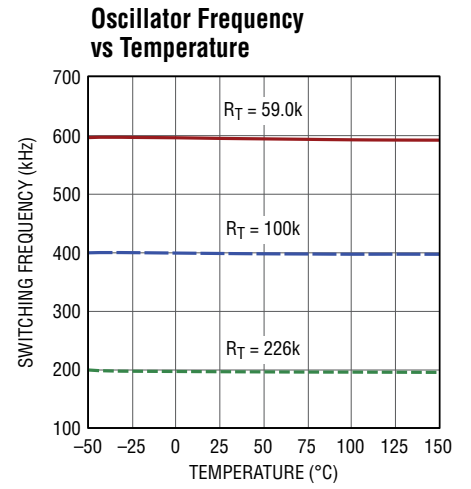
**TYPICAL PERFORMANCE CHARACTERISTICS**  $T_A = 25^\circ\text{C}$ , unless otherwise noted.



8391 G28



8391 G29



8391 G30

## PIN FUNCTIONS

**BG1:** Buck Side Bottom Gate Drive. Drives the gate of buck side bottom N-channel MOSFET with a voltage swing from ground to  $INTV_{CC}$ .

**BST1:** Buck Side Bootstrap Floating Driver Supply. The BST1 pin has an integrated bootstrap Schottky diode from the  $INTV_{CC}$  pin and requires an external bootstrap capacitor to the SW1 pin. The BST1 pin swings from a diode voltage drop below  $INTV_{CC}$  to  $(V_{IN} + INTV_{CC})$ .

**SW1:** Buck Side Switch Node. The SW1 pin swings from a Schottky diode voltage drop below ground up to  $V_{IN}$ .

**TG1:** Buck Side Top Gate Drive. Drives the gate of buck side top N-channel MOSFET with a voltage swing from SW1 to BST1.

**LSP:** Positive Terminal of the Buck Side Inductor Current Sense Resistor ( $R_{SENSE}$ ). Ensure accurate current sense with Kelvin connection.

**LSN:** Negative Terminal of the Buck Side Inductor Current Sense Resistor ( $R_{SENSE}$ ). Ensure accurate current sense with Kelvin connection.

**$V_{IN}$ :** Input Supply. The  $V_{IN}$  pin must be tied to the power input to determine the buck, buck-boost, or boost operation regions. Locally bypass this pin to ground with a minimum  $1\mu\text{F}$  ceramic capacitor.

**$INTV_{CC}$ :** Internal 5V Linear Regulator Output. The  $INTV_{CC}$  linear regulator is supplied from the  $V_{IN}$  pin, and powers the internal control circuitry and gate drivers. Locally bypass this pin to ground with a minimum  $4.7\mu\text{F}$  ceramic capacitor.

**EN/UVLO:** Enable and Undervoltage Lockout. Force the pin below  $0.3\text{V}$  to shut down the part and reduce  $V_{IN}$  quiescent current below  $2\mu\text{A}$ . Force the pin above  $1.227\text{V}$  for normal operation. The accurate  $1.214\text{V}$  falling threshold can be used to program an undervoltage lockout (UVLO) threshold with a resistor divider from  $V_{IN}$  to ground. An accurate  $2.5\mu\text{A}$  pull-down current allows the programming of  $V_{IN}$  UVLO hysteresis. If neither function is used, tie this pin directly to  $V_{IN}$ .

**RP:** Internal PWM Dimming Frequency Setting. The RP pin is used to set the internal PWM dimming frequency with a resistor to ground. Neither uses a resistor larger than  $1\text{M}\Omega$  nor leaves this pin open. If an external PWM dimming pulse is available at the PWM pin, tie this pin to ground.

**PWM:** PWM Dimming Input. The PWM pin can be used in two ways: external PWM dimming and internal PWM dimming. For external PWM dimming, drive this pin with a digital pulse from  $0\text{V}$  to a voltage higher than  $1.5\text{V}$  to control PWM dimming of the LED string. Make sure the RP pin is tied to ground in this case. For internal PWM dimming, apply an analog voltage between  $1\text{V}$  and  $2\text{V}$  to generate an internal digital pulse by comparing with the internal ramp. If PWM dimming is not used, tie this pin to  $INTV_{CC}$ . Forcing the pin low turns off TG1 and TG2, turns on BG1 and BG2, disconnects the  $V_C$  pin from all internal loads, and turns off PWM TG.

**$V_{REF}$ :** Voltage Reference Output. The  $V_{REF}$  pin provides an accurate  $2\text{V}$  reference capable of supplying  $1\text{mA}$  current. Locally bypass this pin to ground with a  $0.47\mu\text{F}$  ceramic capacitor.

**CTRL1:** Control Input for LED Current Sense Threshold. The CTRL1 pin is used to program the LED regulation current:

$$I_{LED} = \frac{\text{Min}(V_{CTRL1} - 0.25\text{V}, V_{CTRL2} - 0.25, 1\text{V})}{10 \cdot R_{LED}}$$

The  $V_{CTRL1}$  can be set by an external voltage reference or a resistor divider from  $V_{REF}$  to ground. For  $0.25\text{V} \leq V_{CTRL1} \leq 1.15\text{V}$ , the current sense threshold linearly goes up from  $0\text{mV}$  to  $90\text{mV}$ . For  $V_{CTRL1} \geq 1.35\text{V}$ , the current sense threshold is constant at  $100\text{mV}$  full scale value. For  $1.15\text{V} \leq V_{CTRL1} \leq 1.35\text{V}$ , the current sense threshold smoothly transitions from the linear function of  $V_{CTRL1}$  to the  $100\text{mV}$  constant value. Tie CTRL1 to  $V_{REF}$  for the  $100\text{mV}$  full scale threshold. Force the pin below  $0.2\text{V}$  to stop switching.

**ISP:** Positive Terminal of the LED Current Sense Resistor ( $R_{LED}$ ). Ensure accurate current sense with Kelvin connection.

## PIN FUNCTIONS

**ISN:** Negative Terminal of the LED Current Sense Resistor ( $R_{LED}$ ). Ensure accurate current sense with Kelvin connection.

**CTRL2:** Thermal Control Input for LED Current Sense Threshold. The CTRL2 pin is used to program LED current derating versus temperature. The  $V_{CTRL2}$  with a negative temperature coefficient can be set by an external temperature dependent resistor divider from  $V_{REF}$  to ground. For  $0.25V \leq V_{CTRL2} \leq 1.15V$ , the current sense threshold linearly goes up from 0mV to 90mV. For  $V_{CTRL2} \geq 1.35V$ , the current sense threshold is constant at 100mV full scale value. For  $1.15V \leq V_{CTRL2} \leq 1.35V$ , the current sense threshold smoothly transitions from the linear function of  $V_{CTRL2}$  to the 100mV constant value. Tie CTRL2 to  $V_{REF}$  for the 100mV full scale threshold. Force the pin below 0.2V to stop switching.

**FAULT:** LED Fault Open Drain Output. The  $\overline{FAULT}$  pin is pulled low when any of the following conditions happens:

1. Open LED ( $V_{FB} > 0.95V$  &  $V_{(ISP-ISN)} < 10mV$ )
2. Short LED ( $V_{FB} < 0.25V$ )

To function, the pin requires an external pull-up resistor. The  $\overline{FAULT}$  status is updated only during PWM high state and latched during PWM low state.

**SS:** Soft-Start Timer Setting. The SS pin is used to set soft-start timer by connecting a capacitor to ground. An internal 12.5 $\mu$ A pull-up current charging the external SS capacitor gradually ramps up FB regulation voltage. A 0.1 $\mu$ F capacitor is recommended on this pin. Any UVLO or thermal shutdown immediately pulls SS pin to ground and stops switching. Using a single resistor from SS to  $V_{REF}$ , the LT8391 can be set in three different fault protection modes during open or short LED fault conditions: hiccup (no resistor), lathoff (499k), and keep-running (100k). See more details in the Applications Information section.

**FB:** Voltage Loop Feedback Input. The FB pin is used for constant-voltage regulation and LED fault protection. The internal error amplifier with its output  $V_C$  regulates  $V_{FB}$  to 1.00V through the DC/DC converter. During open LED ( $V_{FB} > 0.95V$  &  $V_{(ISP-ISN)} < 10mV$ ) or short LED ( $V_{FB} < 0.25V$ ) fault conditions, the part pulls the  $\overline{FAULT}$  pin low and gets into one fault mode per customer setting. During an overvoltage ( $V_{FB} > 1.05V$ ) condition, the part turns off all TG1, BG1, TG2, BG2, and PWMTG.

**$V_C$ :** Error Amplifier Output to Set Inductor Current Comparator Threshold. The  $V_C$  pin is used to compensate the control loop with an external RC network. During PWM low state, the  $V_C$  pin is disconnected from all internal loads to store its voltage information for the highest PWM dimming performance.

**RT:** Switching Frequency Setting. Connect a resistor from this pin to ground to set the internal oscillator frequency from 150kHz to 650kHz.

**SYNC/SPRD:** Switching Frequency Synchronization or Spread Spectrum. Ground this pin for switching at internal oscillator frequency. Apply a clock signal for external frequency synchronization. Tie to  $INTV_{CC}$  for  $\pm 15\%$  triangle spread spectrum around internal oscillator frequency.

**PWMTG:** PWM Dimming Top Gate Drive. A buffered and inverted version of the PWM input signal, the PWMTG pin drives an external high side PMOS PWM switch with a voltage swing from the higher voltage of ( $V_{OUT} - 5V$ ) and 1.2V to  $V_{OUT}$ . Leave this pin unconnected if not used.

**$V_{OUT}$ :** Output Supply. The  $V_{OUT}$  pin must be tied to the power output to determine the buck, buck-boost, or boost operation regions. The  $V_{OUT}$  pin also serves as positive rail for the PWMTG drive. Locally bypass this pin to ground with a minimum 1 $\mu$ F ceramic capacitor.

**TG2:** Boost Side Top Gate Drive. Drives the gate of boost side top N-Channel MOSFET with a voltage swing from SW2 to BST2.

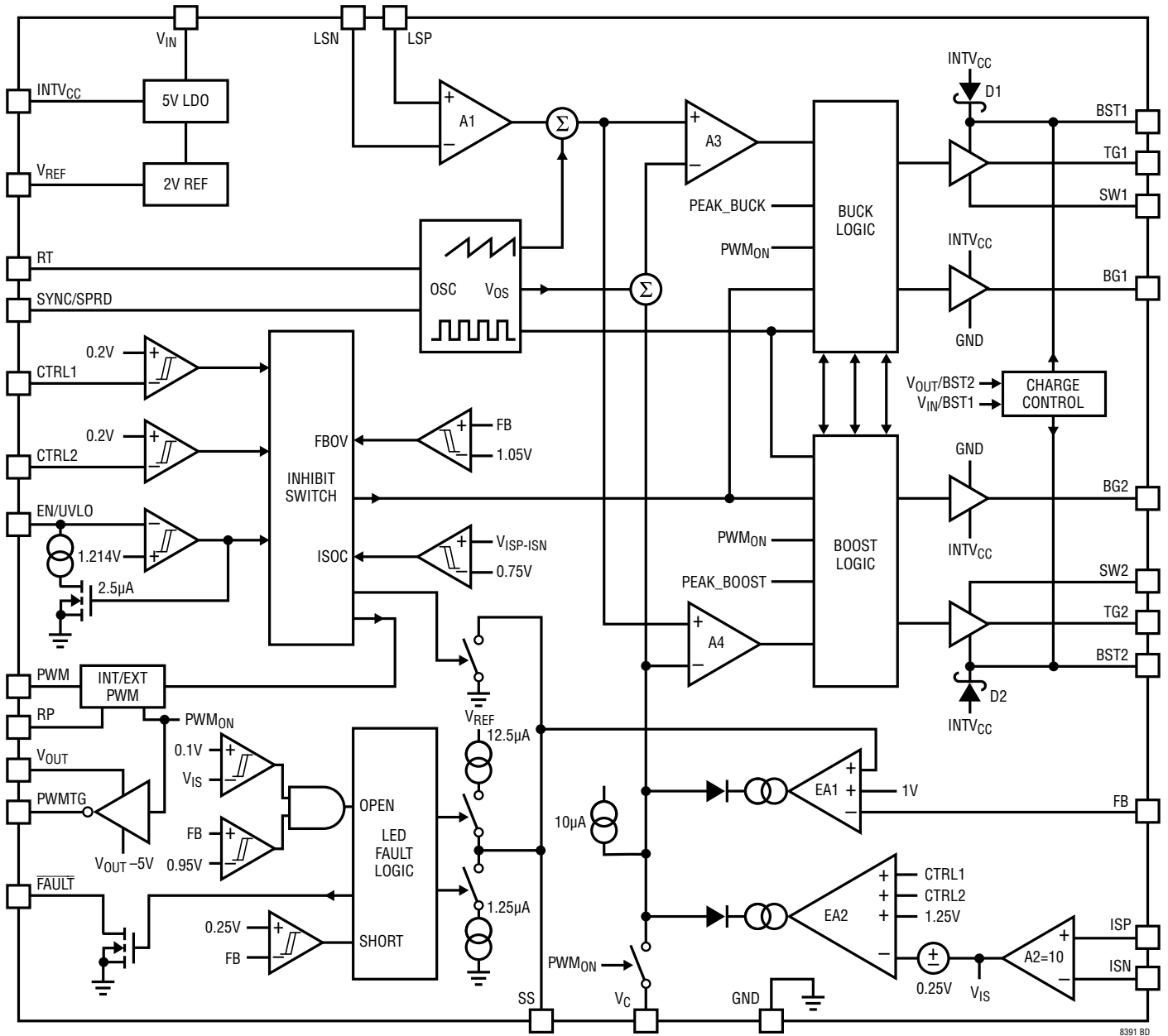
**SW2:** Boost Side Switch Node. The SW2 pin swings from a Schottky diode voltage drop below ground to  $V_{OUT}$ .

**BST2:** Boost Side Bootstrap Floating Driver Supply. The BST2 pin has an integrated bootstrap Schottky diode from the  $INTV_{CC}$  pin and requires an external bootstrap capacitor to the SW2 pin. The BST2 pin swings from a diode voltage drop below  $INTV_{CC}$  to ( $V_{OUT} + INTV_{CC}$ ).

**BG2:** Boost Side Bottom Gate Drive. Drives the gate of boost side bottom N-Channel MOSFET with a voltage swing from ground to  $INTV_{CC}$ .

**GND (Exposed Pad):** Ground. Solder the exposed pad directly to the ground plane.

**BLOCK DIAGRAM**



8391 BD

## OPERATION

The LT8391 is a current mode LED controller that can regulate LED current from input voltage above, below, or equal to the LED string voltage. The ADI proprietary peak-buck peak-boost current mode control scheme uses a single inductor current sense resistor and provides smooth transition between buck region, buck-boost region, and boost region. Its operation is best understood by referring to the Block Diagram.

### Power Switch Control

Figure 1 shows a simplified diagram of how the four power switches A, B, C, and D are connected to the inductor L, the current sense resistor  $R_{SENSE}$ , power input  $V_{IN}$ , power output  $V_{OUT}$ , and ground. The current sense resistor  $R_{SENSE}$  connected to the LSP and LSN pins provides inductor current information for both peak current mode control and reverse current detection in buck region, buck-boost region, and boost region. Figure 2 shows the current mode control as a function of  $V_{IN}/V_{OUT}$  ratio and Figure 3 shows the operation region as a function of  $V_{IN}/V_{OUT}$  ratio. The power switches are properly controlled to smoothly transition between modes and regions.

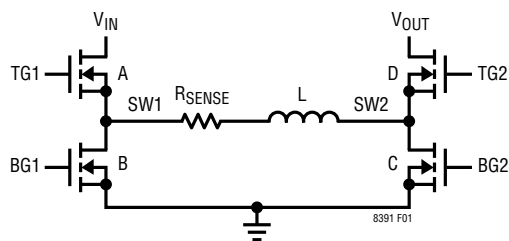


Figure 1. Simplified Diagram of the Power Switches

Hysteresis is added to prevent chattering between modes and regions.

There are total four states: (1) peak-buck current mode control in buck region, (2) peak-buck current mode control in buck-boost region, (3) peak-boost current mode control in buck-boost region, and (4) peak-boost current mode control in boost region. The following sections give detailed description for each state with waveforms,

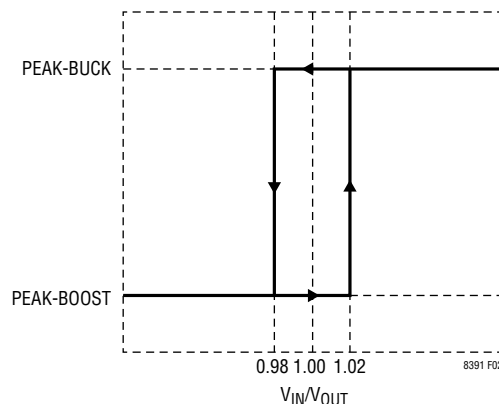


Figure 2. Current Mode vs  $V_{IN}/V_{OUT}$  Ratio

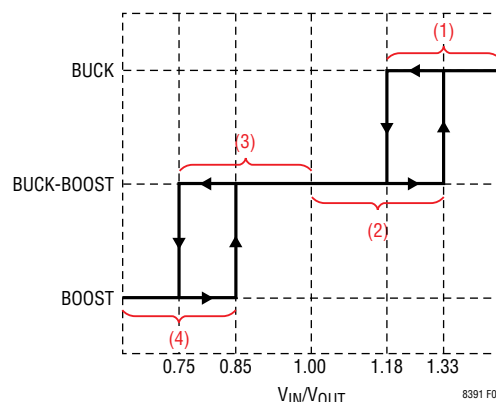


Figure 3. Operation Region vs  $V_{IN}/V_{OUT}$  Ratio

in which the shoot-through protection dead time between switches A and B, between switches C and D are ignored for simplification.

### Peak-Buck in Buck Region ( $V_{IN} \gg V_{OUT}$ )

When  $V_{IN}$  is much higher than  $V_{OUT}$ , the LT8391 uses peak-buck current mode control in buck region (Figure 4). Switch C is always off and switch D is always on. At the beginning of every cycle, switch A is turned on and the inductor current ramps up. When the inductor current hits the peak buck current threshold commanded by  $V_C$  voltage at buck current comparator A3 during (A+D) phase, switch A is turned off and switch B is turned on for the rest of the cycle. Switches A and B will alternate, behaving like a typical synchronous buck regulator.

## OPERATION

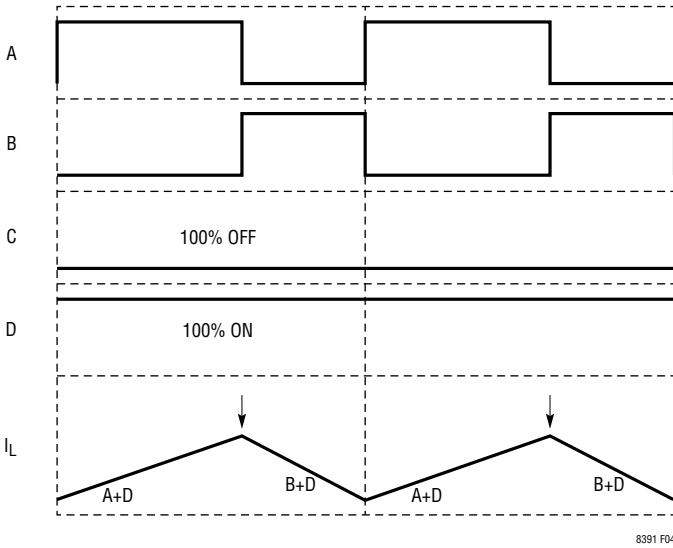


Figure 4. Peak-Buck in Buck Region ( $V_{IN} \gg V_{OUT}$ )

### Peak-Buck in Buck-Boost Region ( $V_{IN} \sim V_{OUT}$ )

When  $V_{IN}$  is slightly higher than  $V_{OUT}$ , the LT8391 uses peak-buck current mode control in buck-boost region (Figure 5). Switch C is always turned on for the beginning 15% cycle and switch D is always turned on for the remaining 85% cycle. At the beginning of every cycle, switches A and C are turned on and the inductor current ramps up. After 15% cycle, switch C is turned off and switch D is turned on, and the inductor keeps ramping up. When the inductor current hits the peak buck current threshold commanded by  $V_C$  voltage at buck current comparator A3 during (A+D) phase, switch A is turned off and switch B is turned on for the rest of the cycle.

### Peak-Boost in Buck-Boost Region ( $V_{IN} \lesssim V_{OUT}$ )

When  $V_{IN}$  is slightly lower than  $V_{OUT}$ , the LT8391 uses peak-boost current mode control in buck-boost region (Figure 6). Switch A is always turned on for the beginning 85% cycle and switch B is always turned on for the remaining 15% cycle. At the beginning of every cycle, switches A and C are turned on and the inductor current ramps up. When the inductor current hits the peak boost current threshold commanded by  $V_C$  voltage at boost current comparator A4 during (A+C) phase, switch C is turned off and switch D is turned on for the rest of the cycle. After 85% cycle, switch A is turned off and switch B is turned on for the rest of the cycle.

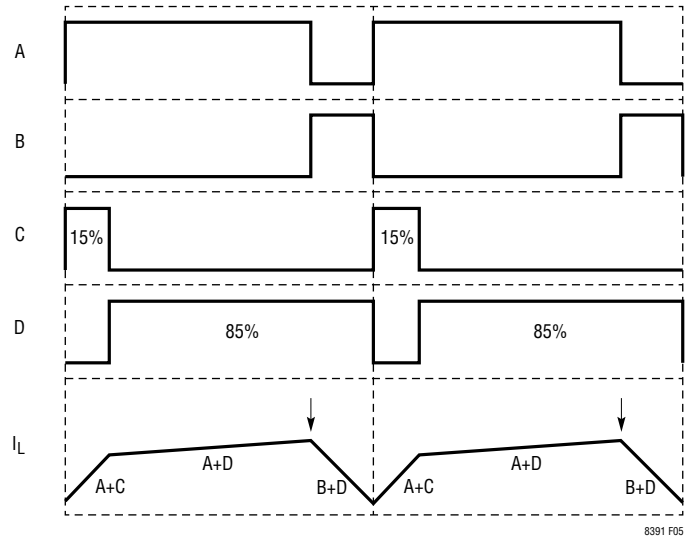


Figure 5. Peak-Buck in Buck-Boost Region ( $V_{IN} \sim V_{OUT}$ )

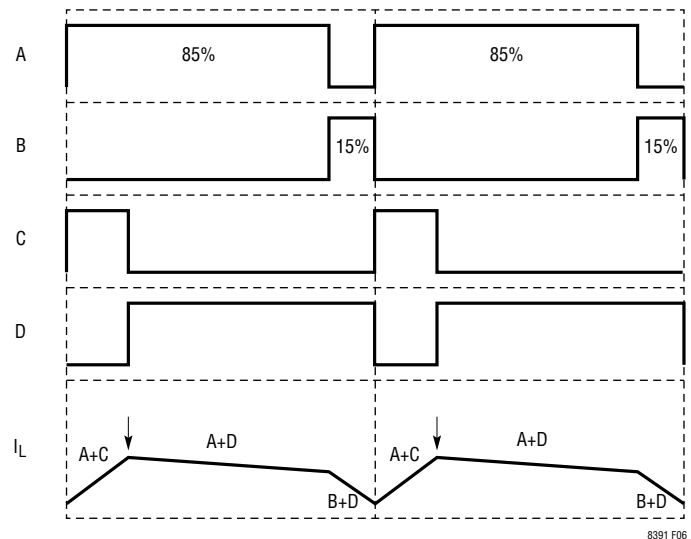


Figure 6. Peak-Boost in Buck-Boost Region ( $V_{IN} \lesssim V_{OUT}$ )

### Peak-Boost in Boost Region ( $V_{IN} \ll V_{OUT}$ )

When  $V_{IN}$  is much lower than  $V_{OUT}$ , the LT8391 uses peak-boost current mode control in boost region (Figure 7). Switch A is always on and switch B is always off. At the beginning of every cycle, switch C is turned on and the inductor current ramps up. When the inductor current hits the peak boost current threshold commanded by  $V_C$  voltage at boost current comparator A4 during (A+C) phase, switch C is turned off and switch D is turned on for the rest of the cycle.



## OPERATION

the cycle. Switches C and D will alternate, behaving like a typical synchronous boost regulator.

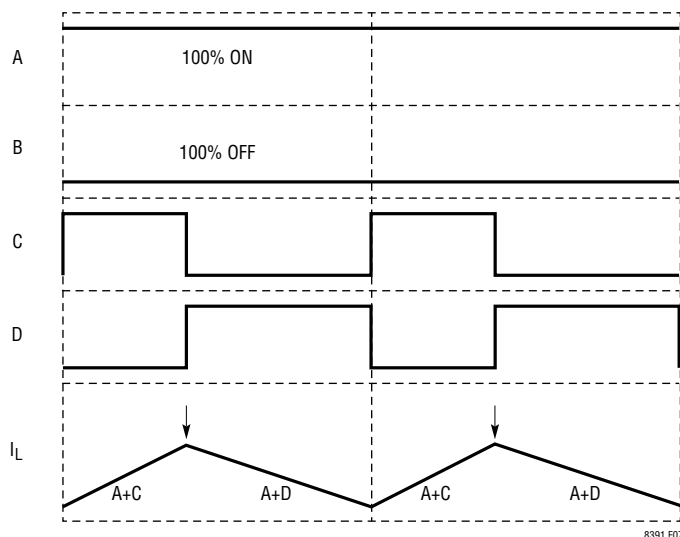


Figure 7. Peak-Boost in Boost Region ( $V_{IN} \ll V_{OUT}$ )

### Main Control Loop

The LT8391 is a fixed frequency current mode controller. The inductor current is sensed through the inductor sense resistor between the LSP and LSN pins. The current sense voltage is gained up by amplifier A1 and added to a slope compensation ramp signal from the internal oscillator. The summing signal is then fed into the positive terminals of the buck current comparator A3 and boost current comparator A4. The negative terminals of A3 and A4 are controlled by the voltage on the  $V_C$  pin, which is the diode-OR of error amplifiers EA1 and EA2.

Depending on the state of the peak-buck peak-boost current mode control, either the buck logic or the boost logic is controlling the four power switches so that either the FB voltage is regulated to 1V or the current sense voltage between the ISP and ISN pins is regulated by the CTRL1 or CTRL2 pin during normal operation. The gains of EA1 and EA2 have been balanced to ensure smooth transition between constant-voltage and constant-current operation with the same compensation network.

### Light Load Current Operation

At light load, the LT8391 typically still runs at its full switching frequency in either continuous conduction mode or discontinuous conduction mode because both the buck and boost reverse current sense thresholds are set to  $-4\text{mV}$ . The negative reverse current sense thresholds allow a small amount of energy flowing from the output to the input in every cycle, thereby preventing the pulse-skip frequency from going below 100Hz, which causes the LED string to flicker.

In the buck region, switch B is turned off whenever the buck reverse current threshold is triggered during (B+D) phase. In the boost region, switch D is turned off whenever the boost reverse current threshold is triggered during (A+D) phase. In the buck-boost region, switch D is turned off whenever the boost reverse current threshold is triggered during (A+D) phase, and both switches B and D are turned off whenever the buck reverse current threshold is triggered during (B+D) phase.

However, when a smaller value inductor is used and the inductor current ripple is bigger, the LT8391 may run in pulse-skip mode, where the switches are held off for multiple cycles (i.e., skipping pulses) to maintain the regulation.

### Internal Charge Path

Each of the two top MOSFET drivers is biased from its floating bootstrap capacitor, which is normally recharged by  $INTV_{CC}$  through the integrated bootstrap diode D1 or D2 when the top MOSFET is turned off. When the LT8391 operates exclusively in the buck or boost regions, one of the top MOSFETs is constantly on. An internal charge path, from  $V_{OUT}$  and BST2 to BST1 or from  $V_{IN}$  and BST1 to BST2, charges the bootstrap capacitor to 4.6V so that the top MOSFET can be kept on.

## OPERATION

### Shutdown and Power-On-Reset

The LT8391 enters shutdown mode and drains less than 2μA quiescent current when the EN/UVLO pin is below its shutdown threshold (0.3V minimum). Once the EN/UVLO pin is above its shutdown threshold (1V maximum), the LT8391 wakes up startup circuitry, generates band-gap reference, and powers up the internal INTV<sub>CC</sub> LDO. The INTV<sub>CC</sub> LDO supplies the internal control circuitry and gate drivers. Now the LT8391 enters undervoltage lockout (UVLO) mode with a hysteresis current (2.5μA typical) pulled into the EN/UVLO pin. When the INTV<sub>CC</sub> pin is charged above its rising UVLO threshold (3.78V typical), the EN/UVLO pin passes its rising enable threshold (1.227V typical), and the junction temperature is less than its thermal shutdown (165°C typical), the LT8391 enters enable mode, in which the EN/UVLO hysteresis current is turned off and the voltage reference V<sub>REF</sub> is being charged up from ground. From the time of entering enable mode to the time of V<sub>REF</sub> passing its rising UVLO threshold (1.89V typical), the LT8391 is going through a power-on-reset (POR), waking up the entire internal control circuitry and settling to the right initial conditions. After the POR, the LT8391 is ready and waiting for the signals on the CTRL1, CTRL2, and PWM pins to start switching.

### Start-Up and Fault Protection

Figure 8 shows the start-up and fault sequence for the LT8391. During the POR state, the SS pin is hard pulled down with a 100Ω to ground. In a pre-biased condition, the SS pin has to be pulled below 0.2V to enter the INIT state, where the LT8391 wait 10μs so that the SS pin can be fully discharged to ground. After the 10μs, the LT8391 enters the UP/PRE state when the PWM<sub>ON</sub> signal goes high. The PWM<sub>ON</sub> high signal happens when both the CTRL1 and CTRL2 pins are above their rising dim-off thresholds (0.228V typical) and the external or internal PWM dimming is on.

During the UP/PRE state, the SS pin is charged up by a 12.5μA pull-up current while the switching is disabled and the PMWTG is turned off. Once the SS pin is charged above 0.25V, the LT8391 enters the UP/TRY state, where the PMWTG is turned on first while the switching is still

disabled. This is to check whether the voltage on the output capacitor is not too high for the LED string before any switching energy delivery. In the case of a higher voltage output capacitor connected to a lower voltage LED string, the excessive current flowing through the LED string and current sense resistor triggers the ISP/ISN over current (ISOC) signal and resets the LT8391 back into the POR state. So the LT8391 will hiccup with SS pin between 0V and 0.25V and go around the POR, INIT, UP/PRE, and UP/TRY states to slowly discharge the higher voltage output capacitor until its voltage gets closer to the lower voltage LED string. After 10μs in the UP/TRY state without triggering the ISOC signal, the LT8391 enters the UP/RUN state.

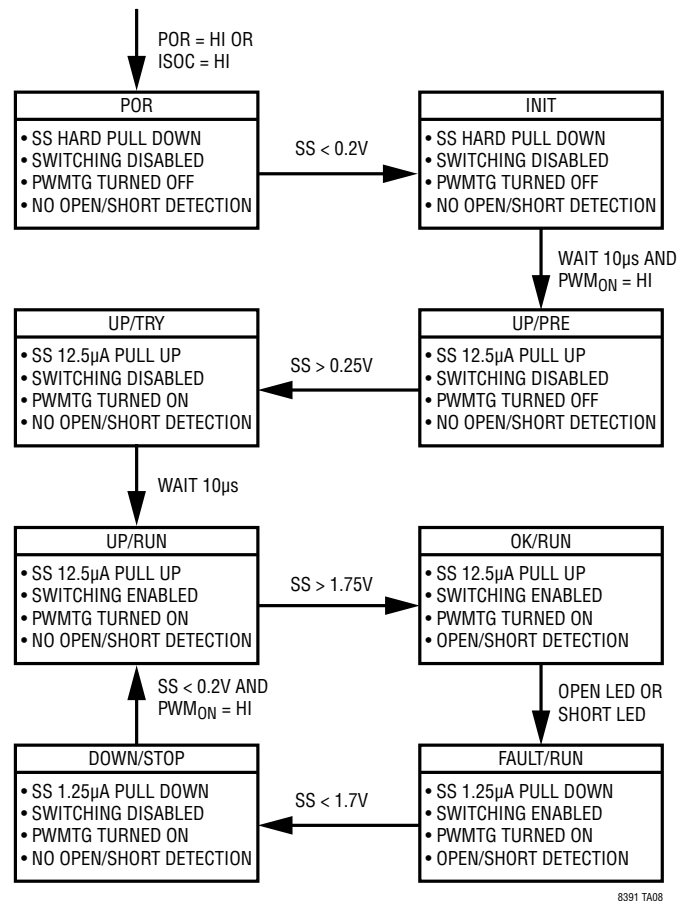


Figure 8. Start-Up and Fault Sequence

## OPERATION

During the UP/RUN state, the switching is enabled and the start-up of the output voltage  $V_{OUT}$  is controlled by the voltage on the SS pin. When the SS pin voltage is less than 1V, the LT8391 regulates the FB pin voltage to the SS pin voltage instead of the 1V reference. This allows the SS pin to be used to program soft-start by connecting an external capacitor from the SS pin to GND. The internal 12.5 $\mu$ A pull-up current charges up the capacitor, creating a voltage ramp on the SS pin. As the SS pin voltage rises linearly from 0.25V to 1V (and beyond), the output voltage  $V_{OUT}$  rises smoothly to its final LED string voltage.

Once the SS pin is charged above 1.75V, the LT8391 enters the OK/RUN state, where the LED fault (both open LED and short LED) detection is activated. The open LED means that  $V_{FB} > 0.95V$  and  $V_{(ISP-ISN)} < 10mV$ , and the short LED means that  $V_{FB} < 0.25V$ . Both the open LED and short LED faults are combined to the  $\overline{FAULT}$  pin. When either fault happens, the LT8391 enters the FAULT/RUN

state, where a 1.25 $\mu$ A pull-down current slowly discharges the SS pin with the other conditions the same as the OK/RUN state. Once the SS pin is discharged below 1.7V, the LT8391 enters the DOWN/STOP state, where the switching is disabled and the LED fault detection is deactivated with the previous fault latched. Once the SS pin is discharged below 0.2V and the  $PWM_{ON}$  signal is still high, the LT8391 goes back to the UP/RUN state.

In an open or short LED condition, the LT8391 can be set to hiccup, latch-off, or keep-running fault protection mode with a resistor between the SS and  $V_{REF}$  pins. Without any resistor, the LT8391 will hiccup with SS pin between 0.2V and 1.75V and go around the UP/RUN, OK/RUN, FAULT/RUN, and DOWN/STOP states until the fault condition is cleared. With a 499k resistor, the LT8391 will latch off until the EN/UVLO is toggled. With a 100k resistor, the LT8391 will keep running regardless of the fault.

## APPLICATIONS INFORMATION

The front page shows a typical LT8391 application circuit. This Applications Information section serves as a guideline of selecting external components for typical applications. The examples and equations in this section assume continuous conduction mode unless otherwise specified.

### Switching Frequency Selection

The LT8391 uses a constant frequency control scheme between 150kHz and 650kHz. Selection of the switching frequency is a trade-off between efficiency and component size. Low frequency operation improves efficiency by reducing MOSFET switching losses, but requires larger inductor and capacitor values. For high power applications, consider operating at lower frequencies to minimize MOSFET heating from switching losses. For low power applications, consider operating at higher frequencies to minimize the total solution size.

In addition, the specific application also plays an important role in switching frequency selection. In a noise-sensitive system, the switching frequency is usually selected to keep the switching noise out of a sensitive frequency band.

### Switching Frequency Setting

The switching frequency of the LT8391 can be set by the internal oscillator. With the SYNC/SPRD pin pulled to ground, the switching frequency is set by a resistor from the RT pin to ground. Table 1 shows  $R_T$  resistor values for common switching frequencies.

**Table 1. Switching Frequency vs  $R_T$  Value (1% Resistor)**

$f_{osc}$ (kHz)	$R_T$ (k)
150	309
200	226
300	140
400	100
500	75
600	59
650	51.1

### Spread Spectrum Frequency Modulation

Switching regulators can be particularly troublesome for applications where electromagnetic interference (EMI) is a concern. To improve the EMI performance, the LT8391

## APPLICATIONS INFORMATION

implements a triangle spread spectrum frequency modulation scheme. With the SYNC/SPRD pin tied to INTV<sub>CC</sub>, the LT8391 starts to spread its switching frequency ±15% around the internal oscillator frequency. Figure 9 and Figure 10 show the noise spectrum comparison of the front page application between spread spectrum enabled and disabled.

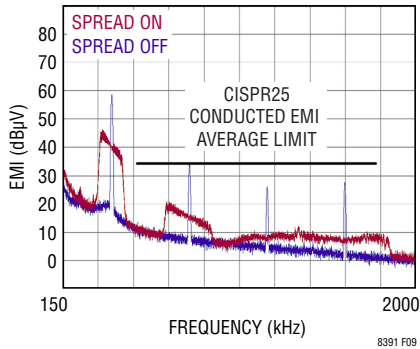


Figure 9. Conducted Average EMI Comparison

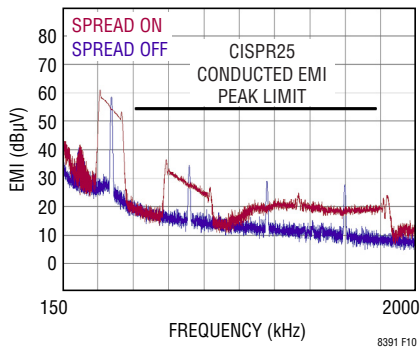


Figure 10. Conducted Peak EMI Comparison

### Frequency Synchronization

The LT8391 switching frequency can be synchronized to an external clock using the SYNC/SPRD pin. Driving the SYNC/SPRD with a 50% duty cycle waveform is always a good choice, otherwise maintain the duty cycle between 10% and 90%. Due to the use of a phase-locked loop (PLL) inside, there is no restriction between the synchronization frequency and the internal oscillator frequency. The rising edge of the synchronization clock represents the beginning of a switching cycle, turning on switches A and C, or switches A and D.

### Inductor Selection

The switching frequency and inductor selection are inter-related in that higher switching frequencies allow the use

of smaller inductor and capacitor values. The inductor value has a direct effect on ripple current. The highest current ripple  $\Delta I_L\%$  happens in the buck region at  $V_{IN(MAX)}$ , and the lowest current ripple  $\Delta I_L\%$  happens in the boost region at  $V_{IN(MIN)}$ . For any given ripple allowance set by customers, the minimum inductance can be calculated as:

$$L_{BUCK} > \frac{V_{OUT} \cdot (V_{IN(MAX)} - V_{OUT})}{f \cdot I_{LED(MAX)} \cdot \Delta I_L \% \cdot V_{IN(MAX)}}$$

$$L_{BOOST} > \frac{V_{IN(MIN)}^2 \cdot (V_{OUT} - V_{IN(MIN)})}{f \cdot I_{LED(MAX)} \cdot \Delta I_L \% \cdot V_{OUT}^2}$$

where:

$f$  is switching frequency

$\Delta I_L\%$  is allowable inductor current ripple

$V_{IN(MIN)}$  is minimum input voltage

$V_{IN(MAX)}$  is maximum input voltage

$V_{OUT}$  is output voltage

$I_{LED(MAX)}$  is maximum LED current

Slope compensation provides stability in constant frequency current mode control by preventing subharmonic oscillations at certain duty cycles. The minimum inductance required for stability can be calculated as:

$$L > \frac{10 \cdot V_{OUT} \cdot R_{SENSE}}{f}$$

For high efficiency, choose an inductor with low core loss, such as ferrite. Also, the inductor should have low DC resistance to reduce the  $I^2R$  losses, and must be able to handle the peak inductor current without saturating. To minimize radiated noise, use a shielded inductor.

### R<sub>SENSE</sub> Selection and Maximum Output Current

$R_{SENSE}$  is chosen based on the required output current. The duty cycle independent maximum current sense thresholds (50mV in peak-buck and 50mV in peak-boost) set the maximum inductor peak current in buck region, buck-boost region, and boost region.

## APPLICATIONS INFORMATION

In boost region, the lowest maximum average load current happens at  $V_{IN(MIN)}$  and can be calculated as:

$$I_{OUT(MAX\_BOOST)} = \left( \frac{50mV}{R_{SENSE}} - \frac{\Delta I_{L(BOOST)}}{2} \right) \cdot \frac{V_{IN(MIN)}}{V_{OUT}}$$

where  $\Delta I_{L(BOOST)}$  is peak-to-peak inductor ripple current in boost region and can be calculated as:

$$\Delta I_{L(BOOST)} = \frac{V_{IN(MIN)} \cdot (V_{OUT} - V_{IN(MIN)})}{f \cdot L \cdot V_{OUT}}$$

In buck region, the lowest maximum average load current happens at  $V_{IN(MAX)}$  and can be calculated as:

$$I_{OUT(MAX\_BUCK)} = \left( \frac{50mV}{R_{SENSE}} - \frac{\Delta I_{L(BUCK)}}{2} \right)$$

where  $\Delta I_{L(BUCK)}$  is peak-to-peak inductor ripple current in buck region and can be calculated as:

$$\Delta I_{L(BUCK)} = \frac{V_{OUT} \cdot (V_{IN(MAX)} - V_{OUT})}{f \cdot L \cdot V_{IN(MAX)}}$$

The maximum current sense  $R_{SENSE}$  in boost region is:

$$R_{SENSE(BOOST)} = \frac{2 \cdot 50mV \cdot V_{IN(MIN)}}{2 \cdot I_{LED(MAX)} \cdot V_{OUT} + \Delta I_{L(BOOST)} \cdot V_{IN(MIN)}}$$

The maximum current sense  $R_{SENSE}$  in buck region is

$$R_{SENSE(BUCK)} = \frac{2 \cdot 50mV}{2 \cdot I_{LED(MAX)} + \Delta I_{L(BUCK)}}$$

The final  $R_{SENSE}$  value should be lower than the calculated  $R_{SENSE}$  in both buck and boost regions. A 20% to 30% margin is usually recommended.

### Power MOSFET Selection

The LT8391 requires four external N-channel power MOSFETs, two for the top switches (switches A and D shown in Figure 1) and two for the bottom switches (switches B and C shown in Figure 1). Important parameters for the power MOSFETs are the breakdown voltage  $V_{BR(DSS)}$ , threshold voltage  $V_{GS(TH)}$ , on-resistance  $R_{DS(ON)}$ , reverse transfer capacitance  $C_{RSS}$  and maximum current  $I_{DS(MAX)}$ .

Since the gate drive voltage is set by the 5V  $INTV_{CC}$  supply, logic-level threshold MOSFETs must be used in LT8391 applications. Switching four MOSFETs at certain frequency, the gate charge current from  $INTV_{CC}$  can be estimated as:

$$I_{INTVCC} = f \cdot (Q_{gA} + Q_{gB} + Q_{gC} + Q_{gD})$$

where:

$f$  is the switching frequency

$Q_{gA}$ ,  $Q_{gB}$ ,  $Q_{gC}$ ,  $Q_{gD}$  are the total gate charges of MOSFETs A, B, C, D.

Make sure the total required  $INTV_{CC}$  current not exceeding the  $INTV_{CC}$  current limit in the data sheet.

The LT8391 uses the  $V_{IN}/V_{OUT}$  ratio to transition between modes and regions. Bigger IR drop in the power path caused by improper MOSFET and inductor selection may prevent the LT8391 from making smooth transitions. To ensure smooth transitions between buck, buck-boost, and boost modes of operation, choose low  $R_{DS(ON)}$  MOSFETs and low DCR inductors to satisfy:

$$I_{LED(MAX)} \leq \frac{0.025 \cdot V_{OUT}}{R_{A,B} + R_{C,D} + R_{SENSE} + R_L}$$

where:

$R_{A,B}$  is the maximum  $R_{DS(ON)}$  of MOSFETs A or B at 25°C

$R_{C,D}$  is the maximum  $R_{DS(ON)}$  of MOSFETs C or D at 25°C

$R_L$  is the maximum DCR resistor of inductor at 25°C

The  $R_{DS(ON)}$  increase at higher junction temperatures and the process variation have been considered and included in the calculation above.

In order to select the power MOSFETs, the power dissipated by the device must be known. For switch A, the maximum power dissipation happens in boost region, when it remains on all the time. Its maximum power dissipation at maximum output current is given by:

$$P_{A(BOOST)} = \left( \frac{I_{LED(MAX)} \cdot V_{OUT}}{V_{IN}} \right)^2 \cdot \rho_T \cdot R_{DS(ON)}$$

where  $\rho_T$  is a normalization factor (unity at 25°C) accounting for the significant variation in on-resistance with



## APPLICATIONS INFORMATION

temperature, typically 0.4%/°C as shown in Figure 11. For a maximum junction temperature of 125°C, using a value of  $\rho_T = 1.5$  is reasonable.

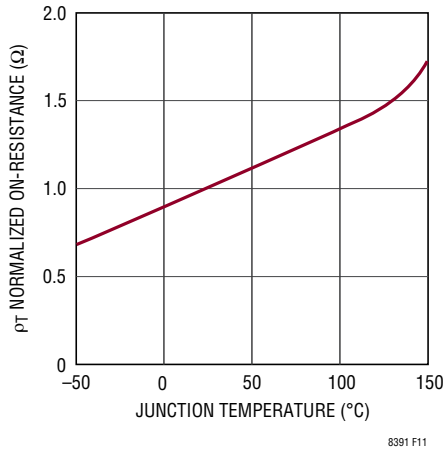


Figure 11. Normalized  $R_{DS(ON)}$  vs Temperature

Switch B operates in buck region as the synchronous rectifier. Its power dissipation at maximum output current is given by:

$$P_{B(BUCK)} = \frac{V_{IN} - V_{OUT}}{V_{IN}} \cdot I_{LED(MAX)}^2 \cdot \rho_T \cdot R_{DS(ON)}$$

Switch C operates in boost region as the control switch. Its power dissipation at maximum current is given by:

$$P_{C(BOOST)} = \frac{(V_{OUT} - V_{IN}) \cdot V_{OUT}}{V_{IN}^2} \cdot I_{LED(MAX)}^2 \cdot \rho_T \cdot R_{DS(ON)} + k \cdot V_{OUT}^3 \cdot \frac{I_{LED(MAX)}}{V_{IN}} \cdot C_{RSS} \cdot f$$

where  $C_{RSS}$  is usually specified by the MOSFET manufacturers. The constant  $k$ , which accounts for the loss caused by reverse recovery current, is inversely proportional to the gate drive current and has an empirical value of 1.7.

For switch D, the maximum power dissipation happens in boost region, when its duty cycle is higher than 50%. Its maximum power dissipation at maximum output current is given by:

$$P_{D(BOOST)} = \frac{V_{OUT}}{V_{IN}} \cdot I_{LED(MAX)}^2 \cdot \rho_T \cdot R_{DS(ON)}$$

For the same output voltage and current, typically switch A has the highest power dissipation in buck region at  $V_{IN(MAX)}$  and switch C has the highest power dissipation in boost region at  $V_{IN(MIN)}$ .

From a known power dissipated in the power MOSFET, its junction temperature can be obtained using the following formula:

$$T_J = T_A + P \cdot R_{TH(JA)}$$

The junction-to-ambient thermal resistance  $R_{TH(JA)}$  includes the junction-to-case thermal resistance  $R_{TH(JC)}$  and the case-to-ambient thermal resistance  $R_{TH(CA)}$ . This value of  $T_J$  can then be compared to the original, assumed value used in the iterative calculation process.

### Optional Schottky Diode ( $D_B$ , $D_D$ ) Selection

The optional Schottky diodes  $D_B$  (in parallel with switch B) and  $D_D$  (in parallel with switch D) conduct during the dead time between the conduction of the power MOSFET switches. They are intended to prevent the body diode of synchronous switches B and D from turning on and storing charge during the dead time. In particular,  $D_B$  significantly reduces reverse recovery current between switch B turn-off and switch A turn-on, and  $D_D$  significantly reduces reverse recovery current between switch D turn-off and switch C turn-on. They improve converter efficiency and reduce switch voltage stress. In order for the diode to be effective, the inductance between it and the synchronous switch must be as small as possible, mandating that these components be placed adjacently.

### $C_{IN}$ and $C_{OUT}$ Selection

Input and output capacitance is necessary to suppress voltage ripple caused by discontinuous current moving in and out the regulator. A parallel combination of capacitors is typically used to achieve high capacitance and low equivalent series resistance (ESR). Dry tantalum, special polymer, aluminum electrolytic and ceramic capacitors are all available in surface mount packages. Capacitors with low ESR and high ripple current ratings, such as OS-CON and POSCAP are also available.

Ceramic capacitors should be placed near the regulator input and output to suppress high frequency switching

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spikes. Ceramic capacitors, of at least 1μF, should also be placed from V<sub>IN</sub> to GND and V<sub>OUT</sub> to GND as close to the LT8391 pins as possible. Due to their excellent low ESR characteristics, ceramic capacitors can significantly reduce input ripple voltage and help reduce power loss in the higher ESR bulk capacitors. X5R or X7R dielectrics are preferred, as these materials retain their capacitance over wide voltage and temperature ranges. Many ceramic capacitors, particularly 0805 or 0603 case sizes, have greatly reduced capacitance at the desired operating voltage.

### Input Capacitance C<sub>IN</sub>

Discontinuous input current is highest in buck region due to the switch A toggling on and off. Make sure that the C<sub>IN</sub> capacitor network has low enough ESR and is sized to handle the maximum RMS current. In buck region, the input RMS current is given by:

$$I_{RMS} \approx I_{LED(MAX)} \cdot \frac{V_{OUT}}{V_{IN}} \cdot \sqrt{\frac{V_{IN}}{V_{OUT}} - 1}$$

The formula has a maximum at V<sub>IN</sub> = 2V<sub>OUT</sub>, where I<sub>RMS</sub> = I<sub>LED(MAX)</sub>/2. This simple worst-case condition is commonly used for design because even significant deviations do not offer much relief.

### Output Capacitance C<sub>OUT</sub>

Discontinuous current shifts from the input to the output in the boost region. Make sure that the C<sub>OUT</sub> capacitor network is capable of reducing the output voltage ripple. The effects of ESR and the bulk capacitance must be considered when choosing the right capacitor for a given output ripple voltage. The maximum steady state ripple due to charging and discharging the bulk capacitance is given by:

$$\Delta V_{CAP(BOOST)} = \frac{I_{LED} \cdot (V_{OUT} - V_{IN(MIN)})}{C_{OUT} \cdot V_{OUT} \cdot f}$$

$$\Delta V_{CAP(BUCK)} = \frac{V_{OUT} \cdot (1 - \frac{V_{OUT}}{V_{IN(MAX)}})}{8 \cdot L \cdot f^2 \cdot C_{OUT}}$$

The maximum steady ripple due to the voltage drop across the ESR is given by:

$$\Delta V_{ESR(BOOST)} = \frac{V_{OUT} \cdot I_{LED(MAX)} \cdot ESR}{V_{IN(MIN)}}$$

$$\Delta V_{ESR(BUCK)} = \frac{V_{OUT} \cdot (1 - \frac{V_{OUT}}{V_{IN(MAX)}})}{L \cdot f} \cdot ESR$$

### INTV<sub>CC</sub> Regulator

An internal P-channel low dropout regulator produces 5V at the INTV<sub>CC</sub> pin from the V<sub>IN</sub> supply pin. The INTV<sub>CC</sub> powers internal circuitry and gate drivers in the LT8391. The INTV<sub>CC</sub> regulator can supply a peak current of 110mA and must be bypassed to ground with a minimum of 4.7μF ceramic capacitor. Good local bypass is necessary to supply the high transient current required by MOSFET gate drivers.

Higher input voltage applications with large MOSFETs being driven at higher switching frequencies may cause the maximum junction temperature rating for the LT8391 to be exceeded. The system supply current is normally dominated by the gate charge current. Additional external loading of the INTV<sub>CC</sub> also needs to be taken into account for the power dissipation calculation. The total LT8391 power dissipation in this case is V<sub>IN</sub> • I<sub>INTVCC</sub>, and overall efficiency is lowered. The junction temperature can be estimated by using the equation:

$$T_J = T_A + P_D \cdot \theta_{JA}$$

where θ<sub>JA</sub> (in °C/W) is the package thermal resistance.

To prevent maximum junction temperature from being exceeded, the input supply current must be checked operating in continuous mode at maximum V<sub>IN</sub>.

### Top Gate MOSFET Driver Supply (C<sub>BST1</sub>, C<sub>BST2</sub>)

The top MOSFET drivers, TG1 and TG2, are driven between their respective SW and BST pin voltages. The boost voltages are biased from floating bootstrap capacitors C<sub>BST1</sub> and C<sub>BST2</sub>, which are normally recharged through internal bootstrap diodes D1 and D2 when the respective top

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MOSFET is turned off. Both capacitors are charged to the same voltage as the  $INTV_{CC}$  voltage. The bootstrap capacitors  $C_{BST1}$  and  $C_{BST2}$ , need to store about 100 times the gate charge required by the top switches A and D. In most applications, a  $0.1\mu\text{F}$  to  $0.47\mu\text{F}$ , X5R or X7R dielectric capacitor is adequate.

### Programming $V_{IN}$ UVLO

A resistor divider from  $V_{IN}$  to the EN/UVLO pin implements  $V_{IN}$  undervoltage lockout (UVLO). The EN/UVLO enable falling threshold is set at 1.214V with 10mV hysteresis. In addition, the EN/UVLO pin sinks  $2.5\mu\text{A}$  when the voltage on the pin is below 1.214V. This current provides user programmable hysteresis based on the value of R1. The programmable UVLO thresholds are:

$$V_{IN(UVLO+)} = 1.227\text{V} \cdot \frac{R1+R2}{R2} + 2.5\mu\text{A} \cdot R1$$

$$V_{IN(UVLO-)} = 1.214\text{V} \cdot \frac{R1+R2}{R2}$$

Figure 12 shows the implementation of external shut-down control while still using the UVLO function. The NMOS grounds the EN/UVLO pin when turned on, and puts the LT8391 in shutdown with quiescent current less than  $2\mu\text{A}$ .

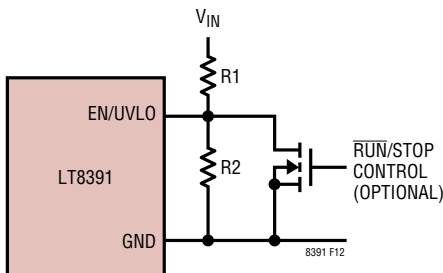


Figure 12.  $V_{IN}$  Undervoltage Lockout (UVLO)

### Programming LED Current

The LED current is programmed by placing an appropriate value current sense resistor,  $R_{LED}$ , in series with the LED string. The voltage drop across  $R_{LED}$  is (Kelvin) sensed by the ISP and ISN pins. The CTRL1 and CTRL2

pins should be tied to a voltage higher than 1.35V to get the full-scale 100mV (typical) threshold across the sense resistor. Either the CTRL1 or CTRL2 pin can be used to dim the LED current to zero, although relative accuracy decreases with the decreasing sense threshold. When either the CTRL1 or CTRL2 pin voltage is less than 1.15V, the LED current is:

$$I_{LED} = \frac{\text{Min}(V_{CTRL1}, V_{CTRL2}) - 250\text{mV}}{10 \cdot R_{LED}}$$

where  $\text{Min}(V_{CTRL1}, V_{CTRL2})$  is the minimum value of CTRL1 and CTRL2 pin voltages. When  $\text{Min}(V_{CTRL1}, V_{CTRL2})$  is between 1.15V and 1.35V, the LED current varies with the  $\text{Min}(V_{CTRL1}, V_{CTRL2})$ , but departs from the equation above by an increasing amount as  $\text{Min}(V_{CTRL1}, V_{CTRL2})$  increases. Ultimately, when  $\text{Min}(V_{CTRL1}, V_{CTRL2}) > 1.35\text{V}$ , the LED current no longer varies. The typical  $V_{(ISP-ISN)}$  threshold vs  $\text{Min}(V_{CTRL1}, V_{CTRL2})$  is listed in Table 2.

Table 2.  $V_{(ISP-ISN)}$  Threshold vs  $\text{Min}(V_{CTRL1}, V_{CTRL2})$

$\text{Min}(V_{CTRL1}, V_{CTRL2})$ (V)	$V_{(ISP-ISN)}$ (mV)
1.15	90
1.20	94.5
1.25	98
1.30	99.5
1.35	100

When  $\text{Min}(V_{CTRL1}, V_{CTRL2})$  is higher than 1.35V, the LED current is regulated to:

$$I_{LED} = \frac{100\text{mV}}{R_{LED}}$$

The CTRL1/CTRL2 pin should not be left open (tie to  $V_{REF}$  if not used). The CTRL1/CTRL2 pin can also be used in conjunction with a thermistor to provide overtemperature protection for the LED load, or with a resistor divider to  $V_{IN}$  to reduce output power and switching current when  $V_{IN}$  is low. The presence of a time varying differential voltage ripple signal across ISP and ISN at the switching frequency is expected. The amplitude of this signal is increased by higher LED load current, lower switching frequency, or smaller value output filter capacitor. Some



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level of ripple signal is acceptable, and the compensation capacitor on the  $V_C$  pin filters the signal so the average difference between ISP and ISN is regulated to the user-programmed value. The ripple voltage amplitude (peak-to-peak) in excess of 20mV should not cause misoperation, but may lead to noticeable offset between the average value and the user-programmed value.

### Dimming Control

There are two methods to control the LED current for dimming using the LT8391. One method uses the CTRL1 or CTRL2 pin to adjust the current regulated in the LEDs. A second method uses the PWM pin to modulate the LED current between zero and full current to achieve a precisely programmed average current.

Compared to the analog dimming method, the PWM dimming method offers much higher dimming ratio without any color shift. To make PWM dimming more accurate, the switch demand current is stored on the  $V_C$  node when the PWM signal is low. This feature minimizes recovery time when the PWM signal goes high. To further improve the recovery time, a high side PMOS PWM switch should be used in the LED current path to prevent the output capacitor from discharging during the PWM signal low phase.

The choice of switching frequency, inductor value, and loop compensation affects the minimum PWM on time, below which the LT8391 loses the LED current regulation. For the same application, the LT8391 achieves the highest PWM dimming ratio (up to 2000:1) in buck region, the medium PWM dimming ratio (up to 1000:1) in buck-boost region, and the lowest PWM dimming ratio (up to 400:1) in boost region.

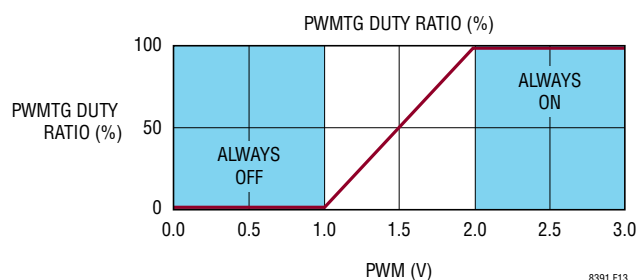
In either fixed frequency operation set by  $R_T$  resistor or spread spectrum frequency operation, the internal oscillator is synchronized to the PWM signal rising edge, thereby providing flicker-free PWM dimming performance. In external frequency synchronization operation, both SYNC and PWM signals must have synchronized rising edges to achieve flicker-free PWM dimming performance.

The LT8391 provides both external PWM dimming and internal PWM dimming. For external PWM dimming, choose  $R_P$  resistor less than 30k and apply external PWM

clock signal on the PWM pin. For internal PWM dimming, choose  $R_P$  resistor to one of the five resistor values in Table 3 and apply analog DC voltage or a resistor divider from  $V_{REF}$  to the PWM pin. The  $R_P$  resistor sets the internal PWM dimming frequency, and the analog DC voltage on the PWM pin from 1V to 2V sets the internal PWM dimming duty ratio from 0% to 100% with a discrete 1/128 step size in Figure 13. A 1 $\mu$ F ceramic capacitor on the PWM pin is recommended to minimize the internal PWM dimming duty ratio jitter caused by switching noise.

**Table 3. Internal PWM Dimming Frequency vs  $R_P$  Value (5% Resistor)**

$R_P$ (k)	$f_{SW}$	$f_{SW} = 200kHz$	$f_{SW} = 400kHz$	$f_{SW} = 600kHz$
$\leq 30$	External	External	External	External
51	$f_{SW}/256$	781Hz	1563Hz	2344Hz
82	$f_{SW}/512$	391Hz	781Hz	1172Hz
130	$f_{SW}/1024$	195Hz	391Hz	586Hz
200	$f_{SW}/2048$	98Hz	195Hz	293Hz
300	$f_{SW}/4096$	49Hz	98Hz	146Hz



**Figure 13. Internal PWM Dimming Duty Ratio vs PWM Voltage**

### High Side PMOS PWM Switch Selection

A high side PMOS PWM switch is recommended in most LT8391 applications to maximize the PWM dimming ratio and protect the LED string during fault conditions. Compared to a low side NMOS PWM switch, the high side PMOS PWM switch allows a single wire to the LED string and ground return path through chassis. The high side PMOS PWM switch is typically selected for drain-source voltage  $V_{DS}$ , gate-source threshold voltage  $V_{GS(TH)}$ , and continuous drain current  $I_D$ . For proper operations,  $V_{DS}$  rating should exceed the open LED regulation voltage set by the FB pin, the absolute value of  $V_{GS(TH)}$  should be less than 3V, and  $I_D$  rating should be above  $I_{LED(MAX)}$ .

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### Programming Output Voltage and Thresholds

The LT8391 has a voltage feedback pin FB that can be used to program a constant-voltage output. The output voltage can be set by selecting the values of R3 and R4 (Figure 14) according to the following equation:

$$V_{OUT} = 1.00V \cdot \frac{R3 + R4}{R4}$$

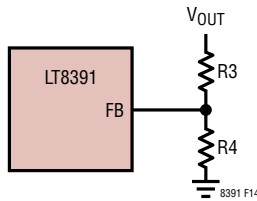


Figure 14. Feedback Resistor Connection

In addition, the FB pin also sets output overvoltage threshold, open LED threshold, and short LED threshold. For an LED driver application with small output capacitors, the output voltage usually overshoots a lot during an open LED event. Although the 1.00V FB regulation loop tries to regulate the output, the loop is usually too slow to prevent the output from overshooting. Once the FB pin hits its overvoltage threshold 1.05V, the LT8391 stops switching by turning off TG1, BG1, TG2, and BG2, and also turns off PWM TG to disconnect the LED string for protection. The output overvoltage threshold can be set as:

$$V_{OUT(OVP)} = 1.05V \cdot \frac{R3 + R4}{R4}$$

Make sure the expected  $V_{FB}$  during normal operation stays between the short LED rising threshold 0.3V and the open LED falling threshold 0.9V:

$$0.3V \leq V_{LED} \cdot \frac{R4}{R3 + R4} \leq 0.9V$$

These equations set the maximum LED string voltage with full open LED protection for the LT8391 to be 51V.

### FAULT Pin

The LT8391 provides an open-drain status pin,  $\overline{FAULT}$ , which is pulled low during either open LED or short LED conditions. The open LED condition happens when the FB pin is above 0.95V and the voltage across  $V_{(ISP-ISM)}$  is less than 10mV. The short LED condition happens when the FB pin is below 0.25V. The  $\overline{FAULT}$  status is updated when the SS pin is above 1.75V and the PWM signal is high.

### Soft-Start and Fault Protection

As shown in Figure 8 and explained in the Operation section, the SS pin can be used to program soft-start by connecting an external capacitor from the SS pin to ground. The internal 12.5 $\mu$ A pull-up current charges up the capacitor, creating a voltage ramp on the SS pin. As the SS pin voltage rises linearly from 0.25V to 1V (and beyond), the output voltage rises smoothly and transitions into LED current regulation. The soft-start range is defined to be the voltage range from 0V to the FB voltage in LED current regulation. The soft-start time can be calculated as:

$$t_{SS} = V_{LED} \cdot \frac{R4}{R3 + R4} \cdot \frac{C_{SS}}{12.5\mu A}$$

Make sure the  $C_{SS}$  is at least five to ten times larger than the compensation capacitor on the  $V_C$  pin. A 0.1 $\mu$ F ceramic capacitor is a good starting point.

The SS pin is also used as a fault timer. Once an open LED or a short LED fault is detected, a 1.25 $\mu$ A pull-down current source is activated. Using a single resistor from the SS pin to the  $V_{REF}$  pin, the LT8391 can be set to three different fault protection modes: hiccup (no resistor), latch-off (499k), and keep-running (100k).

With a 100k resistor in keep-running mode, the LT8391 continues switching normally, either regulating the programmed  $V_{OUT}$  during open LED fault or regulating the current during short LED fault. With a 499k resistor in latch-off mode, the LT8391 stops switching until the EN/UVLO pin is pulled low and high to restart. With no resistor in hiccup mode, the LT8391 enters low duty cycle auto-retry operation. The 1.25 $\mu$ A pull-down current

## APPLICATIONS INFORMATION

discharges the SS pin to 0.2V and then 12.5 $\mu$ A pull-up current charges the SS pin up. If the fault condition has not been removed when the SS pin reaches 1.75V, the 1.25 $\mu$ A pull-down current turns on again, initiating a new hiccup cycle. This will continue until the fault is removed.

### Loop Compensation

The LT8391 uses an internal transconductance error amplifier, the output of which,  $V_C$ , compensates the control loop. The external inductor, output capacitor, and the compensation resistor and capacitor determine the loop stability.

The inductor and output capacitor are chosen based on performance, size and cost. The compensation resistor and capacitor on the  $V_C$  pin are set to optimize control loop response and stability. For a typical LED application, a 10nF compensation capacitor on the  $V_C$  pin is adequate, and a series resistor should always be used to increase the slew rate on the  $V_C$  pin to maintain tighter regulation of LED current during fast transients on the input supply of the converter.

### Efficiency Considerations

The power efficiency of a switching regulator is equal to the output power divided by the input power times 100%. It is often useful to analyze individual losses to determine what is limiting the efficiency and which change would produce the most improvement. Although all dissipative elements in circuits produce losses, four main sources account for most of the losses in LT8391 circuits:

1. DC  $I^2R$  losses. These arise from the resistances of the MOSFETs, sensing resistor, inductor and PC board traces and cause the efficiency to drop at high output currents.
2. Transition loss. This loss arises from the brief amount of time switch A or switch C spends in the saturated region during switch node transitions. It depends upon the input voltage, load current, driver strength and MOSFET capacitance, among other factors.
3.  $INTV_{CC}$  current. This is the sum of the MOSFET driver and control currents.
4.  $C_{IN}$  and  $C_{OUT}$  loss. The input capacitor has the difficult job of filtering the large RMS input current to the regulator in buck region. The output capacitor has the difficult job of filtering the large RMS output current in boost region. Both  $C_{IN}$  and  $C_{OUT}$  are required to have low ESR to minimize the AC  $I^2R$  loss and sufficient capacitance to prevent the RMS current from causing additional upstream losses in fuses or batteries.
5. Other losses. Schottky diode  $D_B$  and  $D_D$  are responsible for conduction losses during dead time and light load conduction periods. Inductor core loss occurs predominately at light loads. Switch A causes reverse recovery current loss in buck region, and switch C causes reverse recovery current loss in boost region.

When making adjustments to improve efficiency, the input current is the best indicator of changes in efficiency. If you make a change and the input current decreases, then the efficiency has increased. If there is no change in the input current, then there is no change in efficiency.

### PC Board Layout Checklist

The basic PC board layout requires a dedicated ground plane layer. Also, for high current, a multilayer board provides heat sinking for power components.

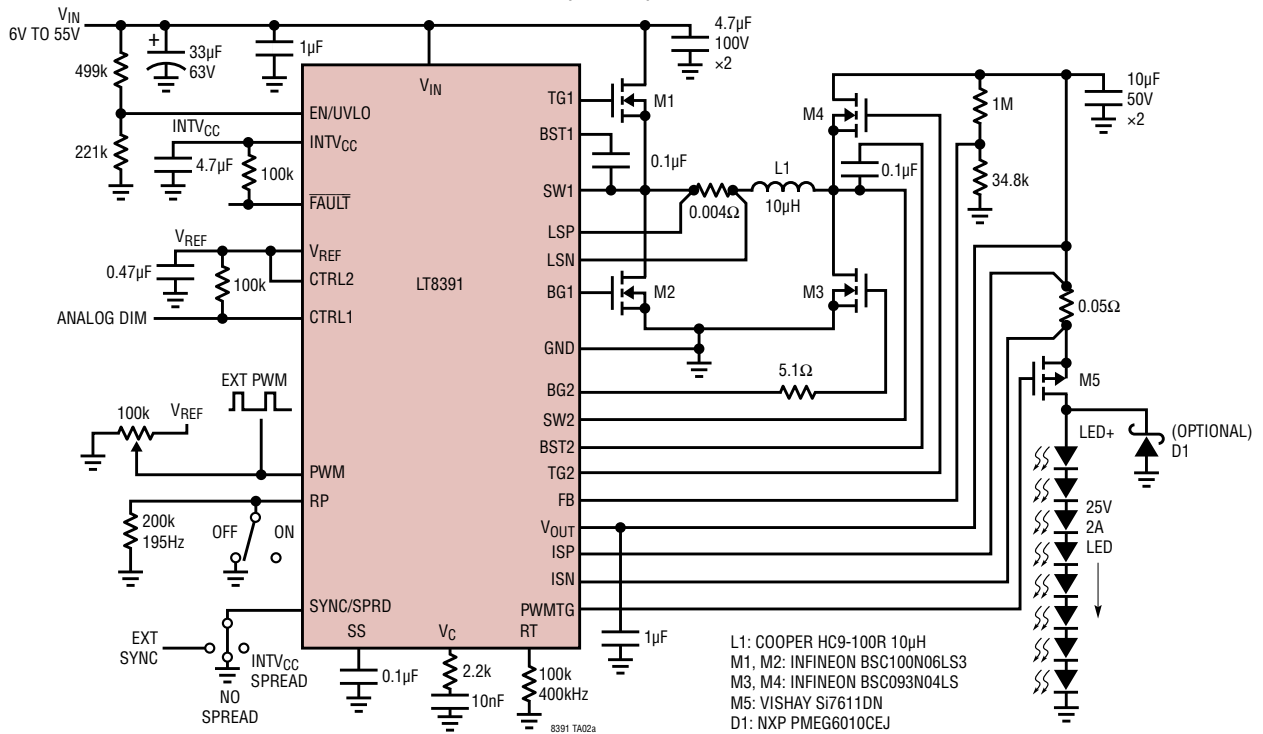
- The ground plane layer should not have any traces and it should be as close as possible to the layer with power MOSFETs.
- Place  $C_{IN}$ , switch A, switch B and  $D_B$  in one compact area. Place  $C_{OUT}$ , switch C, switch D and  $D_D$  in one compact area.
- Use immediate vias to connect the components to the ground plane. Use several large vias for each power component.
- Use planes for  $V_{IN}$  and  $V_{OUT}$  to maintain good voltage filtering and to keep power losses low.

## APPLICATIONS INFORMATION

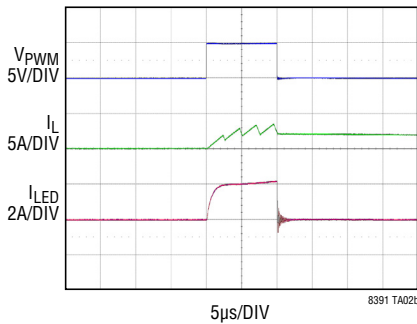
- Flood all unused areas on all layers with copper. Flooding with copper will reduce the temperature rise of power components. Connect the copper areas to any DC net ( $V_{IN}$  or GND).
- Separate the signal and power grounds. All small-signal components should return to the exposed GND pad from the bottom, which is then tied to the power GND close to the sources of switch B and switch C.
- Place switch A and switch C as close to the controller as possible, keeping the power GND, BG and SW traces short. For low  $Q_g$  MOSFET's a  $5.1\Omega$  gate resistor is required for switch C.
- Keep the high  $dV/dT$  SW1, SW2, BST1, BST2, TG1 and TG2 nodes away from sensitive small-signal nodes.
- The path formed by switch A, switch B,  $D_B$  and the  $C_{IN}$  capacitor should have short leads and PCB trace lengths. The path formed by switch C, switch D,  $D_D$  and the  $C_{OUT}$  capacitor also should have short leads and PCB trace lengths.
- The output capacitor (-) terminals should be connected as close as possible to the (-) terminals of the input capacitor.
- Connect the top driver bootstrap capacitor  $C_{BST1}$  closely to the BST1 and SW1 pins. Connect the top driver bootstrap capacitor  $C_{BST2}$  closely to the BST2 and SW2 pins.
- Connect the input capacitors  $C_{IN}$  and output capacitors  $C_{OUT}$  closely to the power MOSFETs. These capacitors carry the MOSFET AC current.
- Route LSP and LSN traces together with minimum PCB trace spacing. Avoid sense lines pass through noisy areas, such as switch nodes. The filter capacitor between LSP and LSN should be as close as possible to the IC. Ensure accurate current sensing with Kelvin connections at the  $R_{SENSE}$  resistor.
- Connect the  $V_C$  pin compensation network close to the IC, between  $V_C$  and the signal ground. The capacitor helps to filter the effects of PCB noise and output voltage ripple voltage from the compensation loop.
- Connect the  $INTV_{CC}$  bypass capacitor,  $C_{INTVCC}$ , close to the IC, between the  $INTV_{CC}$  and the power ground. This capacitor carries the MOSFET drivers' current peaks.

TYPICAL APPLICATIONS

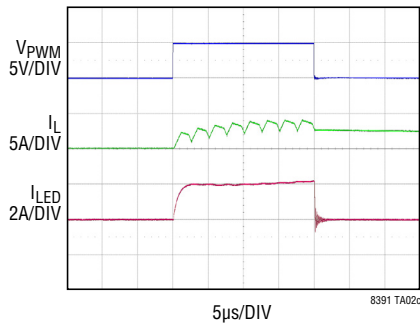
98% Efficient 50W (25V 2A) Buck-Boost LED Driver



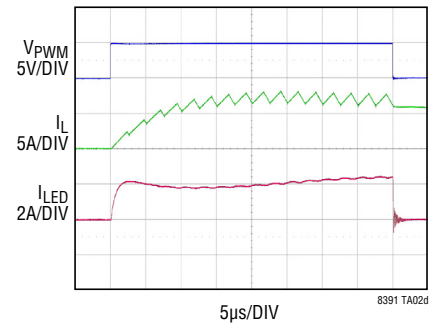
100Hz 1000:1 External PWM Dimming ( $V_{IN} = 36V$ )



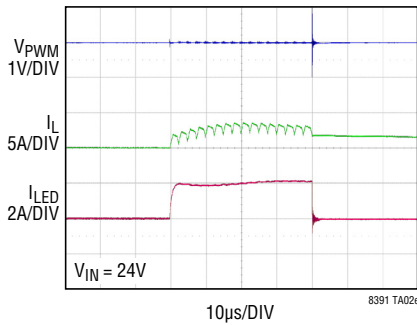
100Hz 500:1 External PWM Dimming ( $V_{IN} = 24V$ )



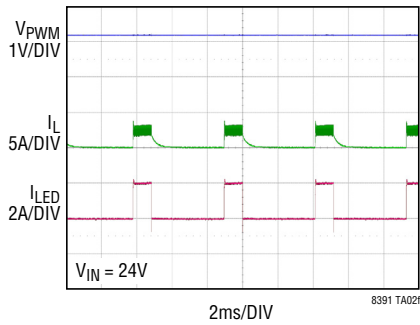
100Hz 250:1 External PWM Dimming ( $V_{IN} = 12V$ )



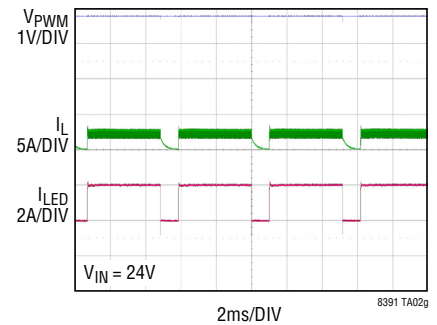
195Hz 128:1 Internal PWM Dimming ( $V_{PWM} = 1V$ )



195Hz 20% Internal PWM Dimming ( $V_{PWM} = 1.2V$ )

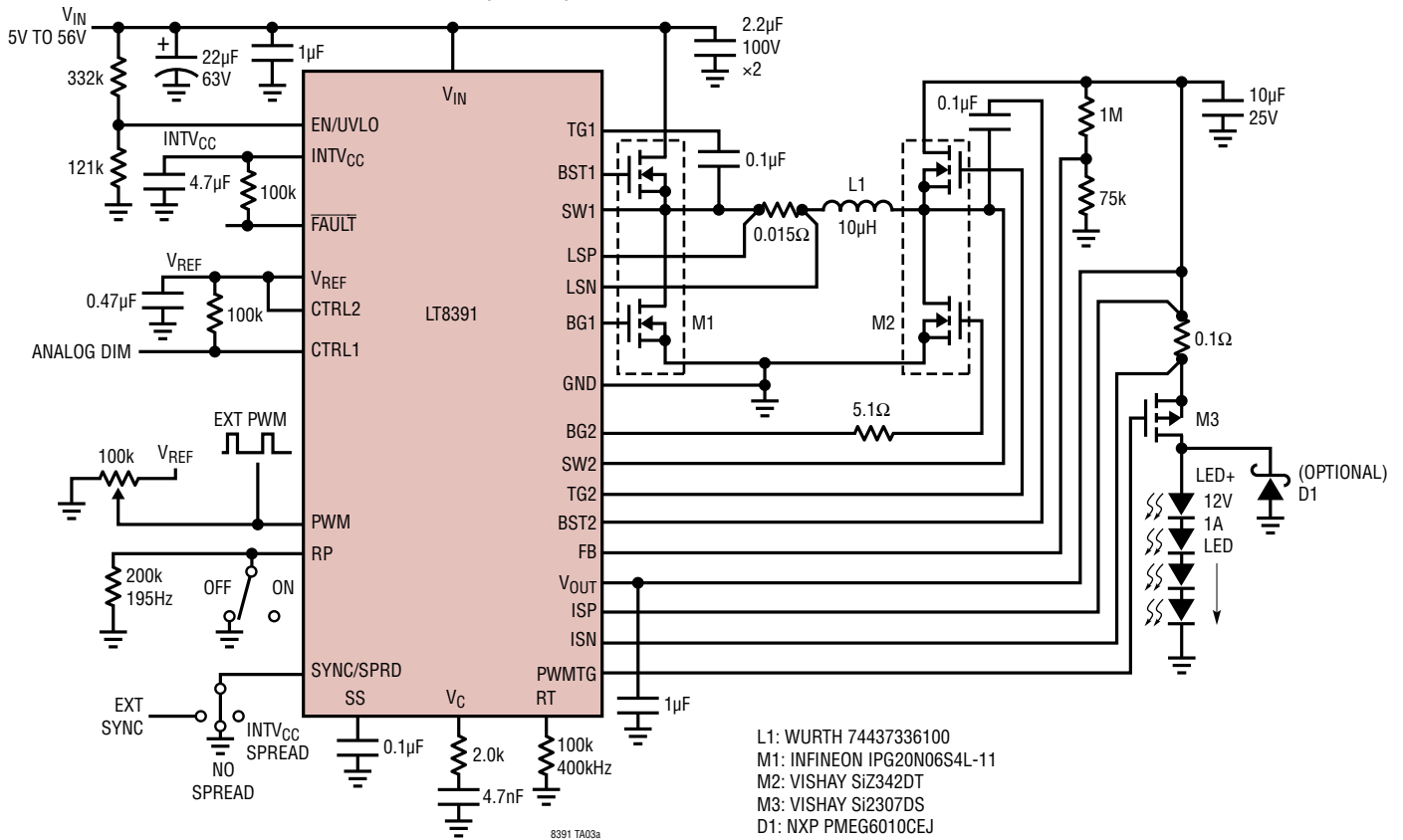


195Hz 80% Internal PWM Dimming ( $V_{PWM} = 1.8V$ )

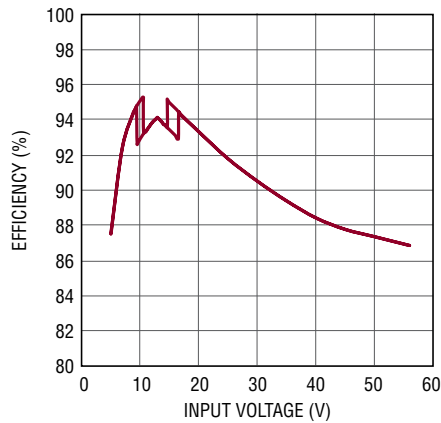


## TYPICAL APPLICATIONS

### 95% Efficient 12W (12V 1A) Buck-Boost LED Driver with Dual Package MOSFETs

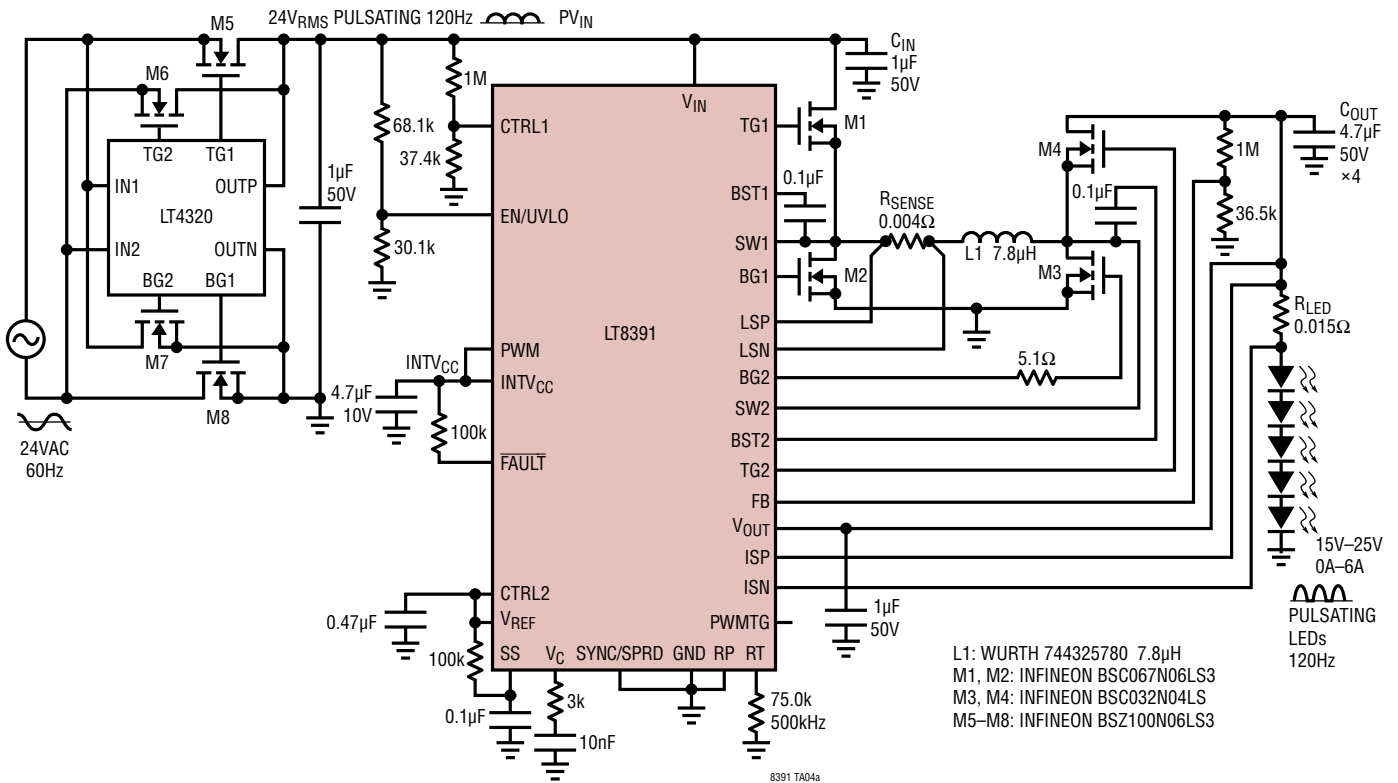


Efficiency vs  $V_{IN}$

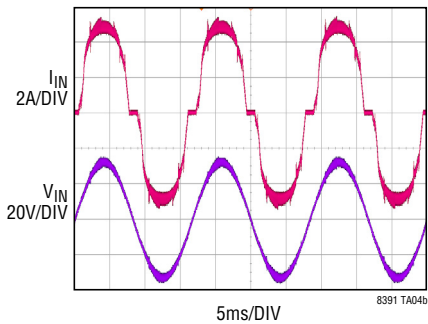


# TYPICAL APPLICATIONS

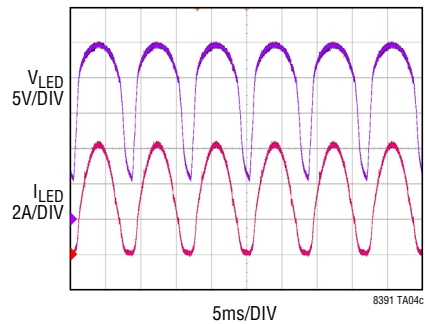
## 93% Efficient 84W Buck-Boost LED Driver from 24VAC



**98% Power Factor from 60Hz 24VAC Input**



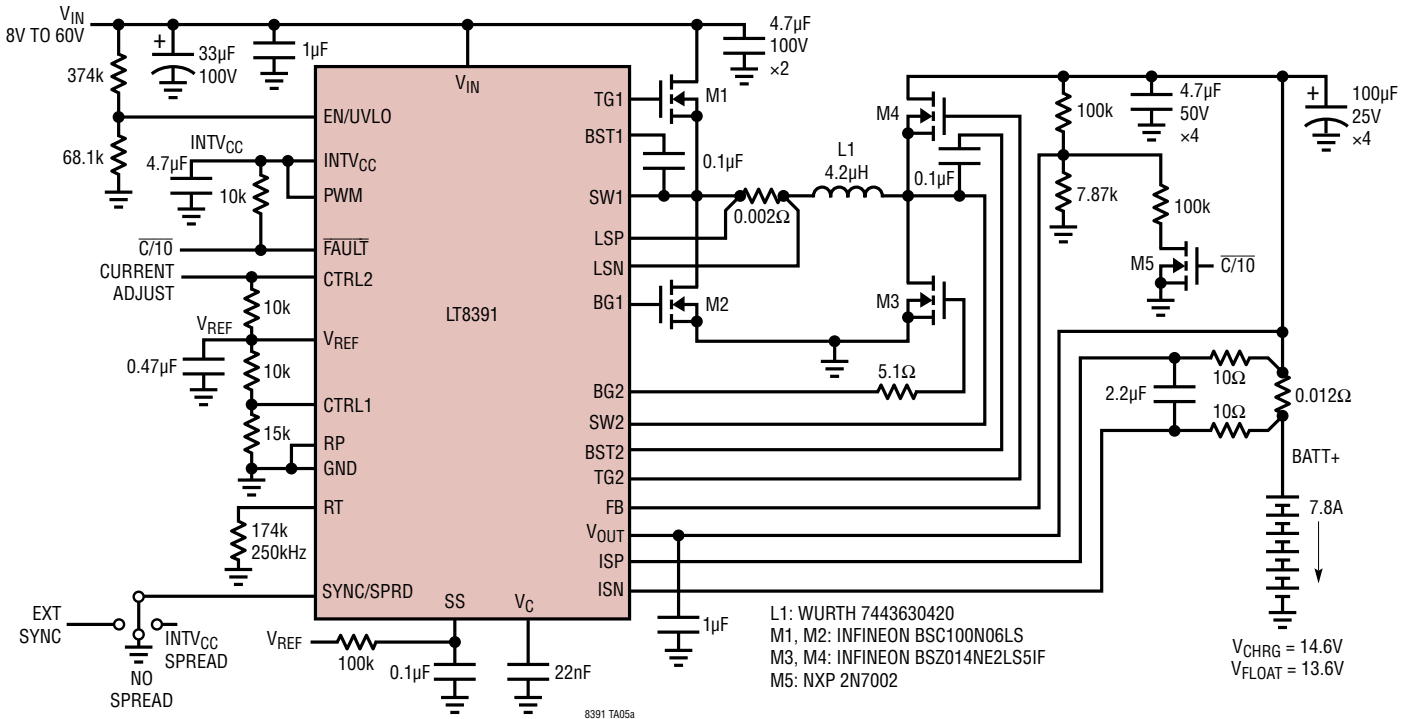
**84W 120Hz AC LED Output**



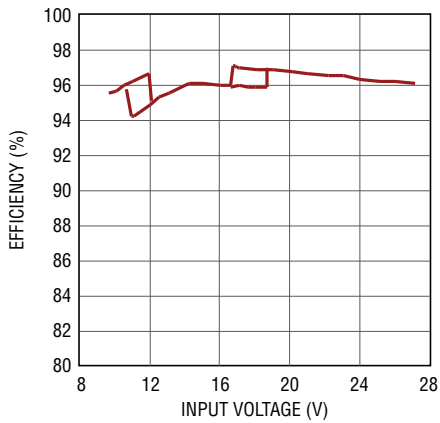


## TYPICAL APPLICATIONS

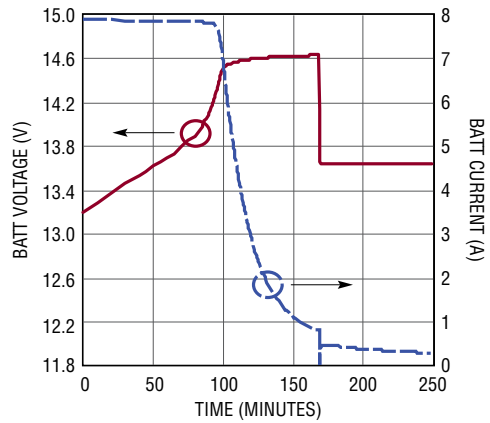
### 97% Efficient 8A Buck-Boost SLA Battery Charger



**Efficiency vs  $V_{IN}$**



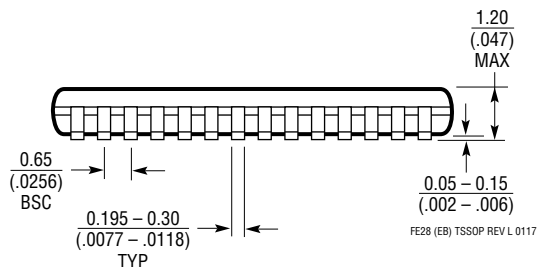
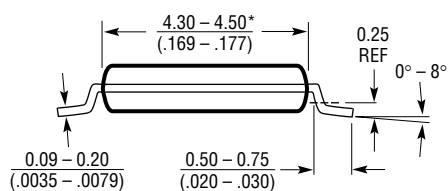
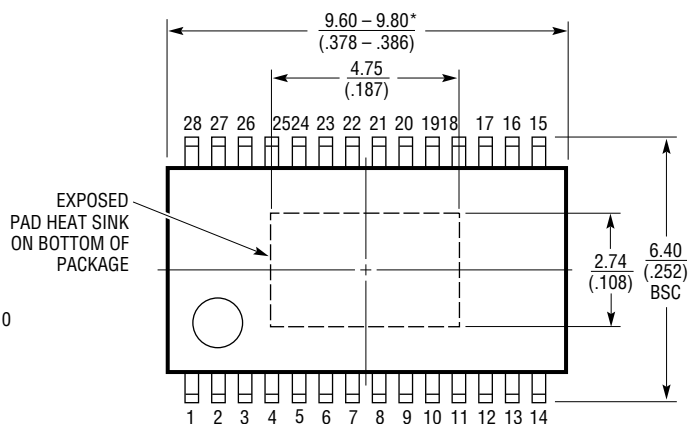
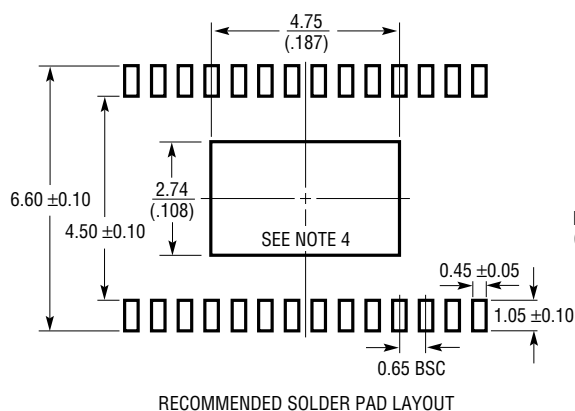
**Charge Profile**





# PACKAGE DESCRIPTION

**FE Package**  
**28-Lead Plastic TSSOP (4.4mm)**  
 (Reference LTC DWG # 05-08-1663 Rev L)  
**Exposed Pad Variation EB**



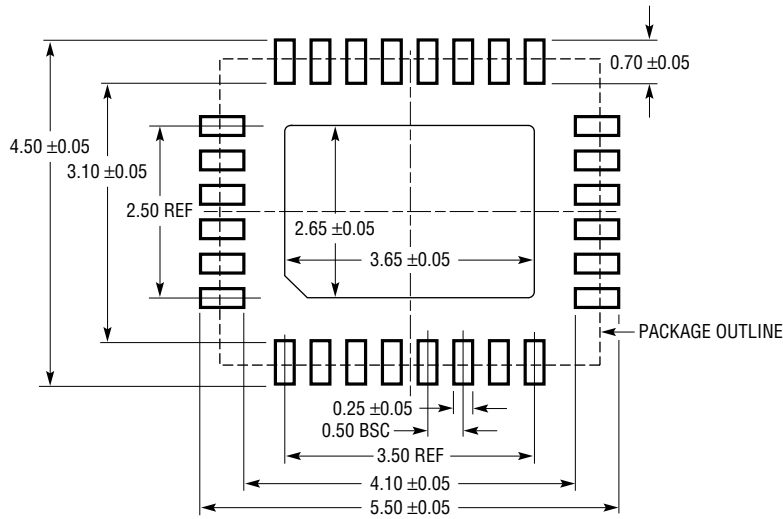
**NOTE:**

1. CONTROLLING DIMENSION: MILLIMETERS
2. DIMENSIONS ARE IN MILLIMETERS (INCHES)
3. DRAWING NOT TO SCALE

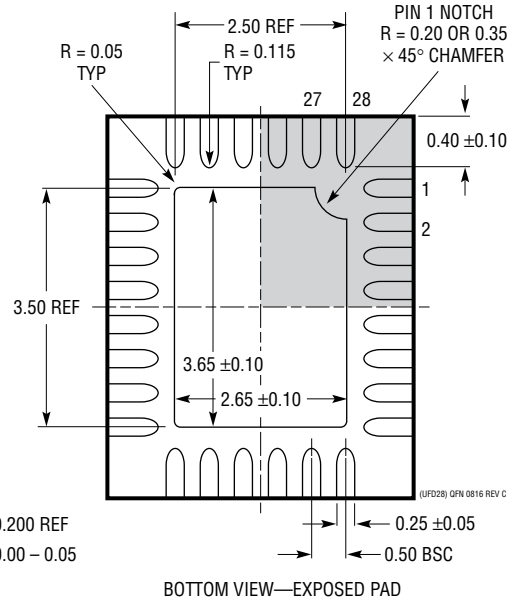
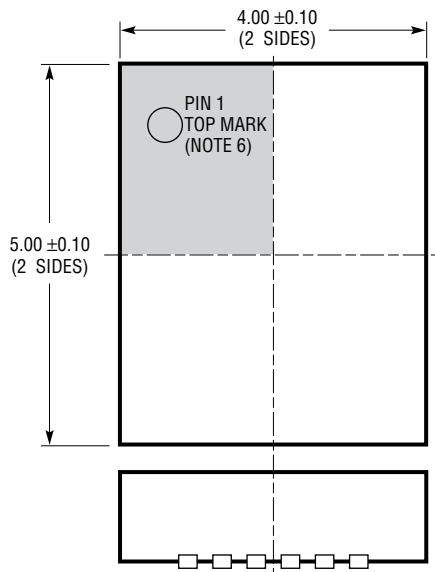
4. RECOMMENDED MINIMUM PCB METAL SIZE FOR EXPOSED PAD ATTACHMENT
- \*DIMENSIONS DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.150mm (.006") PER SIDE

**PACKAGE DESCRIPTION**

**UFD Package**  
**28-Lead Plastic QFN (4mm × 5mm)**  
 (Reference LTC DWG # 05-08-1712 Rev C)



RECOMMENDED SOLDER PAD PITCH AND DIMENSIONS  
 APPLY SOLDER MASK TO AREAS THAT ARE NOT SOLDERED



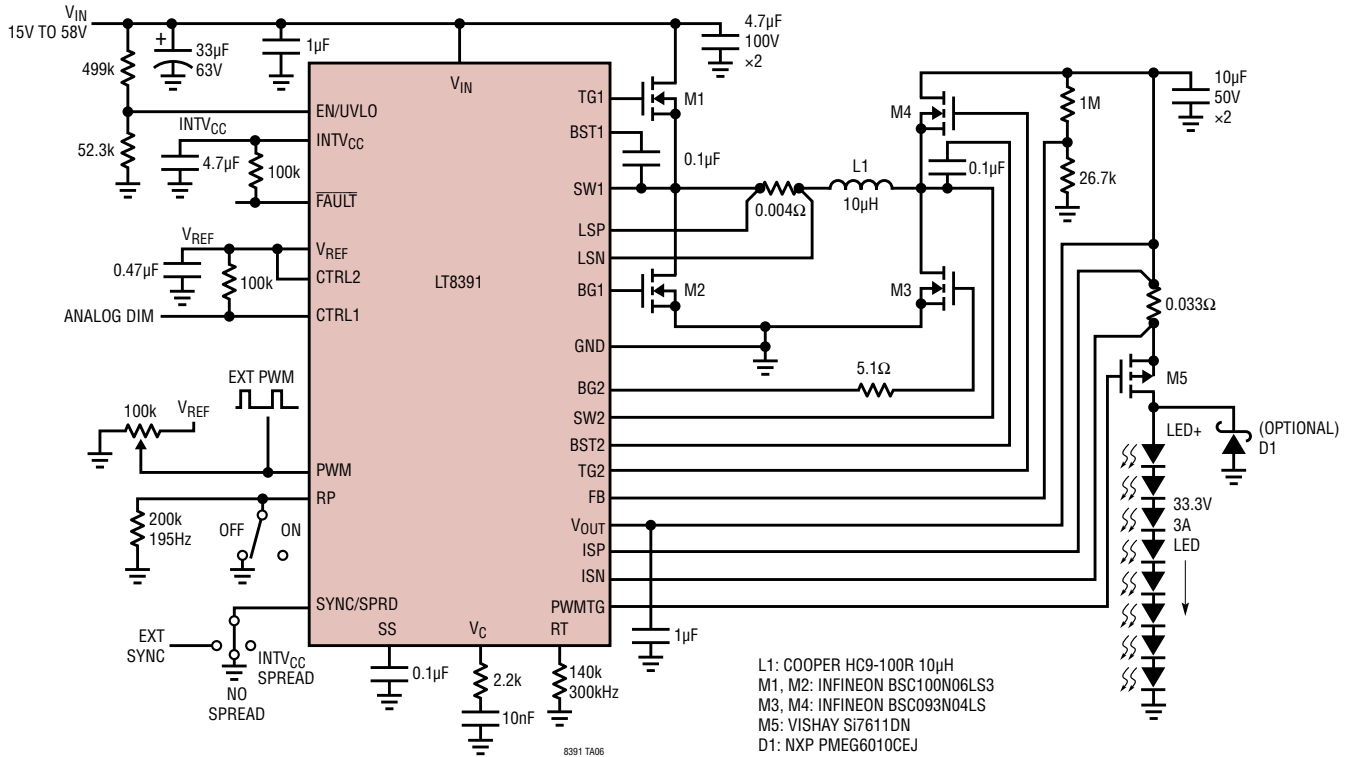
- NOTE:
1. DRAWING PROPOSED TO BE MADE A JEDEC PACKAGE OUTLINE MO-220 VARIATION (WGHD-3).
  2. DRAWING NOT TO SCALE
  3. ALL DIMENSIONS ARE IN MILLIMETERS
  4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
  5. EXPOSED PAD SHALL BE SOLDER PLATED
  6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE

## REVISION HISTORY

REV	DATE	DESCRIPTION	PAGE NUMBER
A	12/17	Minor grammatical edits.	1
		Added H-Grade version.	2
		Clarified INTV <sub>CC</sub> Load and Line Regulation parameters.	3
		Clarified V <sub>REF</sub> Load and Line Regulation parameters.	3
		Clarified FB Load and Line Regulation parameters.	4
		Clarified Highest and Lowest Spread Spectrum Above/Below Oscillator Frequency parameters.	5
		Clarified Region Transition specifications.	6
		Clarified TG1 Minimum/Maximum Duty Cycle Region.	6
		Clarified BG2 Minimum/Maximum Duty Cycle Region.	6
		Added H-Grade to Note 2.	6
		Clarified EN/ULVO paragraph.	11
		Clarified Block Diagram.	13
		Clarified Shutdown and Power-On Reset and Start-Up Fault Protection sections.	17
		Clarified Inductor Selection paragraph.	19
		Clarified Power MOSFET Selection section.	20
		Clarified Typical Application.	28
Clarified Typical Application.	29		
Clarified Typical Application.	34		
B	06/21	Added AEC-Q100 Qualified for Automotive Applications to Features section.	1
		Added LT8391J to Operating Junction Temperature Range section.	2
		Changed theta J <sub>A</sub> to 43°C/W of UFD Package	2
		Added "AUTOMOTIVE PRODUCTS*" and supplemental text to Ordering Information table.	3
		Updated Note 2.	7

## TYPICAL APPLICATION

### 98% Efficient 100W (33.3V 3A) Buck-Boost LED Driver



## RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
<a href="#">LT3791</a>	60V, 700kHz 4-Switch Synchronous Buck-Boost LED Controller	$V_{IN}$ : 4.7V to 60V, $V_{OUT}$ : 0V to 60V, $\pm 6\%$ Current Accuracy, TSSOP-38
<a href="#">LT3743</a>	36V, 1MHz Synchronous Buck LED Controller with Three-State Control	$V_{IN}$ : 6V to 36V, $V_{OUT}$ : 0V to $V_{IN} - 2V$ , $\pm 6\%$ Current Accuracy, Fast Three-State Current Control, 4mm $\times$ 5mm QFN-28 and TSSOP-28
<a href="#">LT3744</a>	36V, 1MHz Synchronous Buck LED Controller with Four-State Control	$V_{IN}$ : 3.3V to 36V, $V_{OUT}$ : 0V to 36V, $\pm 2\%$ Current Accuracy, Fast Four-State Current Control, 5mm $\times$ 6mm QFN-36
<a href="#">LT3763</a>	60V, 1MHz Synchronous Buck LED Controller	$V_{IN}$ : 6V to 60V, $V_{OUT}$ : 0V to $V_{IN} - 2V$ , $\pm 6\%$ Current Accuracy, TSSOP-28
<a href="#">LT3755/LT3755-1/LT3755-2</a>	40V <sub>IN</sub> , 75V <sub>OUT</sub> , 1MHz Non-Synchronous Boost LED Controller	$V_{IN}$ : 4.5V to 40V, $V_{OUT}$ : $V_{IN}$ to 75V, $\pm 4\%$ Current Accuracy, 3mm $\times$ 3mm QFN-16 and MSE-16
<a href="#">LT3756/LT3756-1/LT3756-2</a>	100V, 1MHz Non-Synchronous Boost LED Controller	$V_{IN}$ : 6V to 100V, $V_{OUT}$ : $V_{IN}$ to 100V, $\pm 4\%$ Current Accuracy, 3mm $\times$ 3mm QFN-16 and MSE-16
<a href="#">LT3761</a>	60V <sub>IN</sub> , 80V <sub>OUT</sub> , 1MHz Non-Synchronous Boost LED Controller with Internal PWM Generator	$V_{IN}$ : 4.5V to 60V, $V_{OUT}$ : $V_{IN}$ to 80V, $\pm 3\%$ Current Accuracy, External and Internal PWM dimming, MSE-16
<a href="#">LT3795</a>	110V, 1MHz Non-Synchronous Boost LED Controller with Spread Spectrum Frequency Modulation	$V_{IN}$ : 4.5V to 110V, $V_{OUT}$ : $V_{IN}$ to 110V, $\pm 3\%$ Current Accuracy, Internal Spread Spectrum, TSSOP-28
<a href="#">LT3797</a>	Triple, 40V <sub>IN</sub> , 100V <sub>OUT</sub> , 1MHz Non-Synchronous Boost LED Controller	$V_{IN}$ : 2.5V to 40V (60V Ride-Through), $V_{OUT}$ : $V_{IN}$ to 100V, $\pm 3\%$ Current Accuracy, 7mm $\times$ 8mm QFN-52(47)